Crystal Oscillator (SPXO)

· Package size (5.0 mm × 3.2 mm × 1.1 mm)
· Fundamental mode SPXO
· Output: CMOS
· Reference weight Typ.52 mg

[1] Product Number / Product Name / Marking

(1-1) Product Number / Ordering Code

X1G0044510029xx

Last 2 digits code(**xx**) defines Quantity.
The standard is "00", 1 000 pcs/Reel.

(1-2) Product Name / Model Name

SG5032CAN 24.576000 MHz TJGA

[2] Operating Range

Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Supply voltage	V_{CC}	1.60	-	3.63	V	-
	GND	0	-	0	V	-
Operating temperature range	T_use	-40	-	+85	°C	-
CMOS load condition	L_CMOS	-	-	15	pF	-

[3] Frequency Characteristics

(Unless stated otherwise [2] Operating Range)

Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Output frequency	fo	-	24.576000	-	MHz	-
Frequency tolerance *1	f_tol	-50	-	+50	$\times 10^{-6}$	T_use
Frequency aging	f_age	-3	-	+3	$\times 10^{-6}$	+25 ºC, First year

*1 Frequency tolerance includes Initial frequency tolerance, Frequency / temperature characteristics, Frequency / voltage coefficient and Frequency / load coefficient.

[4] Electrical Characteristics

(Unless stated otherwise [2] Operating Range)

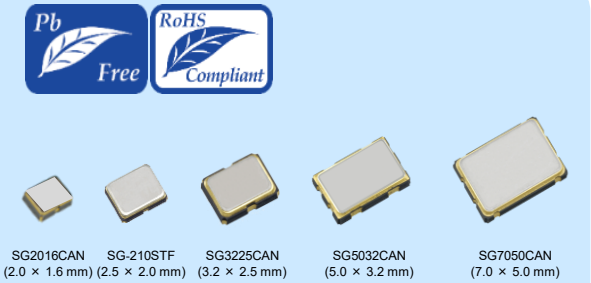
Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Start-up time	t_str	-	-	3.0	ms	t = 0 at 90 % Vcc
Current consumption	I_{CC}	-	-	2.2	mA	No load condition, Vcc = 3.3 V
Stand-by current	I_std	-	-	2.7	µA	$\overline{ST}$ = GND, Vcc = 3.3 V
Output voltage	V_{OH}	90 % Vcc	-	-	V	IOH = -4 mA @Vcc = 3.3 V
	V_{OL}	-	-	10 % Vcc	V	IOL = 4 mA @Vcc = 3.3 V
Rise time	tr	-	-	3.5	ns	20 % Vcc to 80 % Vcc Level, L_CMOS = 15 pF, Vcc = 1.8 V ± 10 %
Fall time	tf	-	-	3.5	ns	80 % Vcc to 20 % Vcc Level, L_CMOS = 15 pF, Vcc = 1.8 V ± 10 %
Symmetry	SYM	45	-	55	%	50 % Vcc Level, L_CMOS ≤ 15 pF
Input voltage	V_{IH}	80 % Vcc	-	-	V	$\overline{ST}$ terminal
	V_{IL}	-	-	20 % Vcc	V	$\overline{ST}$ terminal
Output disable time (ST)	tstp_st	-	-	100	ns	$\overline{ST}$ terminal HIGH → LOW
Output enable time (ST)	tsta_st	-	-	3	ms	$\overline{ST}$ terminal LOW → HIGH

[For other general specifications, please refer to the attached Full Data Sheet below]

Crystal oscillator: SG2016 / 3225 / 5032 / 7050CAN & SG-210STF

Features

- Crystal oscillator (SPXO)
- Frequency: 20 standard frequencies (4 MHz to 72 MHz)
- Output: CMOS
- Supply voltage: 1.6 V to 3.63 V
- Operating temperature: -20 ºC to +70 ºC
  -40 ºC to +105 ºC



Applications

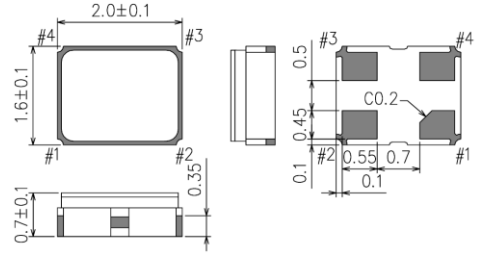
- IoT, Wearable device
- Data center, Storage
- Medical, Industrial automation

Description

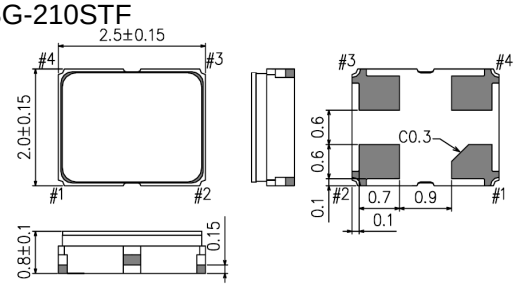
Epson's SGxxxxCAN & SG-210STF are Simple Packaged Crystal Oscillator (SPXO) series with CMOS output. These SPXO's are ideal for variety of applications from IoT, wearables, medical, industrial automation, etc. These SPXO have low current consumption, wide operating voltage from 1.6 V to 3.63 V and wide operating temperature range from -40 ºC to 85 ºC, in addition operation up to 105 ºC is available. These SPXO's are available in five different package size from 2.0 × 1.6 mm to 7.0 × 5.0 mm and available in standard pin out's.

Outline Drawing and Terminal Assignment

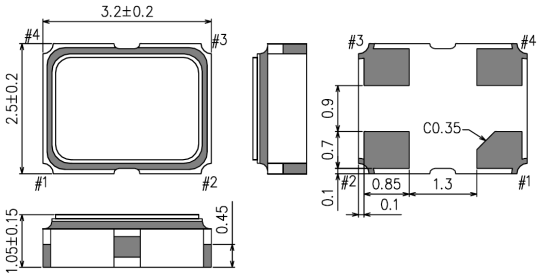
SG2016CAN



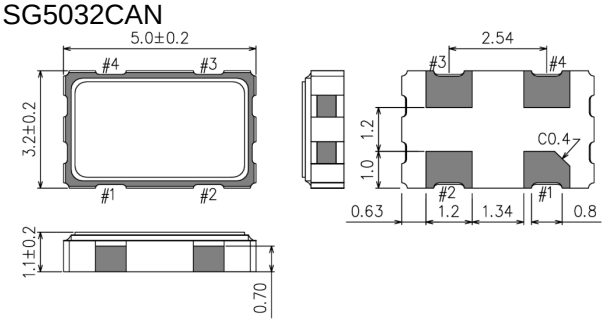
SG-210STF



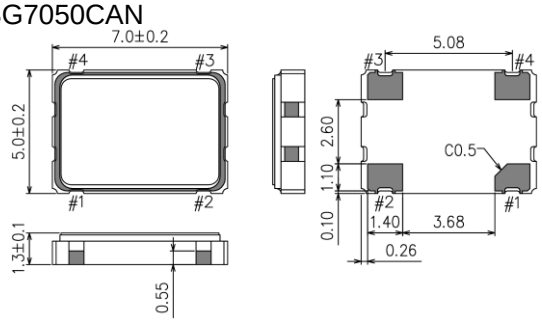
SG3225CAN



SG5032CAN



SG7050CAN



Terminal Assignment

Pin #	Connection	Function		
#1	$\overline{ST}$	$\overline{ST}$ terminal		
		$\overline{ST}$ function	Osc. Circuit	Output
		"H" or OPEN	Oscillation	Specified frequency : Enable
		"L"	Oscillation stop	High impedance : Disable
#2	GND	GND terminal		
#3	OUT	Output terminal		
#4	V_{CC}	V_{CC} terminal		

[1] Product Name / Product Number

(1-1) SG2016CAN

(1) Product Name (Standard Form)

SG2016 C AN 25.000000MHz T J H A

① ② ③ ④⑤⑥⑦

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

④Supply voltage Refer to Figure 1	
T	1.8 V to 3.3 V Typ.
K	2.5 V to 3.3 V Typ.

*Figure 1 is on the next page

⑤Frequency tolerance / ⑥Operating temperature	
DB	±25 × 10^{-6} / -20 ºC to +70 ºC
JG	±50 × 10^{-6} / -40 ºC to +85 ºC
JH	±50 × 10^{-6} / -40 ºC to +105 ºC

(2) Product Number / Ordering Code

Frequency [MHz]	Frequency tolerance / Operating temperature		
	DB	JG	JH
	±25 × 10^{-6} -20 ºC to +70 ºC	±50 × 10^{-6} -40 ºC to +85 ºC	±50 × 10^{-6} -40 ºC to +105 ºC
4	-	X1G004801003000	X1G004801004900
8	-	X1G004801004500	X1G004801004600
10	-	X1G004801002900	X1G004801002700
12	X1G004801005000	X1G004801000700	X1G004801005100
12.288	X1G004801005200	X1G004801004400	X1G004801005300
14.7456	-	X1G004801005400	X1G004801005500
16	-	X1G004801001400	X1G004801005600
20	X1G004801005700	X1G004801005800	X1G004801001800
24	X1G004801005900	X1G004801000200	X1G004801004000
24.576	-	X1G004801006000	X1G004801003100
25	X1G004801002400	X1G004801001200	X1G004801003500
26	-	X1G004801000300	X1G004801003900
27	-	X1G004801006100	X1G004801002100
32	-	X1G004801006200	X1G004801006300
33.33	-	X1G004801006400	X1G004801006500
33.3333	-	X1G004801002600	X1G004801006600
40	-	X1G004801006700	X1G004801003600
48	X1G004801006800	X1G004801002000	X1G004801006900
50	X1G004801007000	X1G004801001300	X1G004801002800
72	X1G004801007100	X1G004801007200	X1G004801007300

(1-2) SG-210STF

(1) Product Name (Standard Form)

SG-210 S T F 25.000000MHz Y

① ②③ ④ ⑤

①Model ②Function (S:Standby) ③Supply voltage

④Frequency ⑤Frequency tolerance / Operating temperature

③Supply voltage Refer to Figure 1	
T	1.8 V to 3.3 V Typ.

*Figure 1 is on the next page

⑤Frequency tolerance / Operating temperature	
S	±25 × 10^{-6} / -20 ºC to +70 ºC
L	±50 × 10^{-6} / -40 ºC to +85 ºC
Y	±50 × 10^{-6} / -40 ºC to +105 ºC

(2) Product Number / Ordering Code

Frequency [MHz]	Frequency tolerance / Operating temperature		
	S	L	Y
	±25 × 10^{-6} -20 ºC to +70 ºC	±50 × 10^{-6} -40 ºC to +85 ºC	±50 × 10^{-6} -40 ºC to +105 ºC
4	-	X1G004171000900	X1G004171029900
8	-	X1G004171001500	X1G004171006900
10	-	X1G004171001600	X1G004171036500
12	X1G004171016300	X1G004171001800	X1G004171028000
12.288	X1G004171006100	X1G004171001900	X1G004171036600
14.7456	-	X1G004171002500	X1G004171036700
16	-	X1G004171002700	X1G004171015400
20	X1G004171021800	X1G004171002900	X1G004171023800
24	X1G004171015600	X1G004171003100	X1G004171019700
24.576	-	X1G004171003200	X1G004171036800
25	X1G004171007700	X1G004171003300	X1G004171005900
26	-	X1G004171003400	X1G004171024400
27	-	X1G004171003500	X1G004171025000
32	-	X1G004171004000	X1G004171012700
33.33	-	X1G004171011900	X1G004171030000
33.3333	-	X1G004171012000	X1G004171007500
40	-	X1G004171004500	X1G004171020600
48	X1G004171007800	X1G004171004600	X1G004171036900
50	X1G004171007900	X1G004171004700	X1G004171012600
72	X1G004171037000	X1G004171012400	X1G004171037100

(1-3) SG3225CAN

(1) Product Name (Standard Form)

SG3225 C AN 25.000000MHz T J H A

① ② ③ ④⑤⑥⑦

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

④Supply voltage Refer to Figure 1	
T	1.8 V to 3.3 V Typ.
K	2.5 V to 3.3 V Typ.

*Figure 1 is on the next page

⑤Frequency tolerance / ⑥Operating temperature	
DB	±25 × 10^{-6} / -20 ºC to +70 ºC
JG	±50 × 10^{-6} / -40 ºC to +85 ºC
JH	±50 × 10^{-6} / -40 ºC to +105 ºC

(2) Product Number / Ordering Code

Frequency [MHz]	Frequency tolerance / Operating temperature		
	DB	JG	JH
	±25 × 10^{-6} -20 ºC to +70 ºC	±50 × 10^{-6} -40 ºC to +85 ºC	±50 × 10^{-6} -40 ºC to +105 ºC
4	-	X1G005961001115	X1G005961001215
8	-	X1G005961000415	X1G005961001315
10	-	X1G005961000515	X1G005961001415
12	X1G005961001515	X1G005961000615	X1G005961001615
12.288	X1G005961001715	X1G005961001815	X1G005961001915
14.7456	-	X1G005961002015	X1G005961002115
16	-	X1G005961002215	X1G005961002315
20	X1G005961002415	X1G005961000715	X1G005961002515
24	X1G005961002615	X1G005961000115	X1G005961002715
24.576	-	X1G005961000815	X1G005961002815
25	X1G005961002915	X1G005961000215	X1G005961003015
26	-	X1G005961003115	X1G005961003215
27	-	X1G005961003315	X1G005961003415
32	-	X1G005961003515	X1G005961003615
33.33	-	X1G005961003715	X1G005961003815
33.3333	-	X1G005961003915	X1G005961004015
40	-	X1G005961000915	X1G005961004115
48	X1G005961004215	X1G005961000315	X1G005961004315
50	X1G005961004415	X1G005961001015	X1G005961004515
72	X1G005961004615	X1G005961004715	X1G005961004815

(1-4) SG5032CAN

(1) Product Name (Standard Form)

SG5032 C AN 25.000000MHz T J H A

① ② ③ ④⑤⑥⑦

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

④Supply voltage Refer to Figure 1	
T	1.8 V to 3.3 V Typ.
K	2.5 V to 3.3 V Typ.

*Figure 1 is on the next page

⑤Frequency tolerance / ⑥Operating temperature	
DB	±25 × 10^{-6} / -20 ºC to +70 ºC
JG	±50 × 10^{-6} / -40 ºC to +85 ºC
JH	±50 × 10^{-6} / -40 ºC to +105 ºC

(2) Product Number / Ordering Code

Frequency [MHz]	Frequency tolerance / Operating temperature		
	DB	JG	JH
	±25 × 10^{-6} -20 ºC to +70 ºC	±50 × 10^{-6} -40 ºC to +85 ºC	±50 × 10^{-6} -40 ºC to +105 ºC
4	-	X1G004451003400	X1G004451019600
8	-	X1G004451002100	X1G004451019700
10	-	X1G004451001300	X1G004451017800
12	X1G004451019800	X1G004451002800	X1G004451019900
12.288	X1G004451020000	X1G004451000100	X1G004451020100
14.7456	-	X1G004451001900	X1G004451020200
16	-	X1G004451000200	X1G004451020300
20	X1G004451020400	X1G004451001100	X1G004451020500
24	X1G004451017200	X1G004451000300	X1G004451020600
24.576	-	X1G004451002900	X1G004451020700
25	X1G004451009700	X1G004451000400	X1G004451020800
26	-	X1G004451008200	X1G004451020900
27	-	X1G004451000500	X1G004451021000
32	-	X1G004451001400	X1G004451021100
33.33	-	X1G004451021200	X1G004451021300
33.3333	-	X1G004451016700	X1G004451021400
40	-	X1G004451001200	X1G004451021500
48	X1G004451014900	X1G004451000700	X1G004451011200
50	X1G004451011500	X1G004451000800	X1G004451003600
72	X1G004451021600	X1G004451021700	X1G004451021800

(1-5) SG7050CAN

(1) Product Name (Standard Form)

SG7050 C AN 25.000000MHz T J H A

① ② ③ ④⑤⑥⑦

①Model ②Output (C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature ⑦Internal identification code ("A" is default)

④Supply voltage Refer to Figure 1	
T	1.8 V to 3.3 V Typ.
K	2.5 V to 3.3 V Typ.

*Figure 1 is on the next page

⑤Frequency tolerance / ⑥Operating temperature	
DB	±25 × 10^{-6} / -20 ºC to +70 ºC
JG	±50 × 10^{-6} / -40 ºC to +85 ºC
JH	±50 × 10^{-6} / -40 ºC to +105 ºC

(2) Product Number / Ordering Code

Frequency [MHz]	Frequency tolerance / Operating temperature		
	DB	JG	JH
	±25 × 10^{-6} -20 ºC to +70 ºC	±50 × 10^{-6} -40 ºC to +85 ºC	±50 × 10^{-6} -40 ºC to +105 ºC
4	-	X1G004481005100	X1G004481025200
8	-	X1G004481001400	X1G004481025300
10	-	X1G004481000500	X1G004481025400
12	X1G004481025500	X1G004481000600	X1G004481025600
12.288	X1G004481025700	X1G004481000100	X1G004481025800
14.7456	-	X1G004481002500	X1G004481025900
16	-	X1G004481000700	X1G004481026000
20	X1G004481012800	X1G004481000800	X1G004481026100
24	X1G004481002200	X1G004481000200	X1G004481026200
24.576	-	X1G004481001600	X1G004481026300
25	X1G004481011600	X1G004481000300	X1G004481026400
26	-	X1G004481003500	X1G004481026500
27	-	X1G004481000400	X1G004481026600
32	-	X1G004481000900	X1G004481026700
33.33	-	X1G004481017900	X1G004481026800
33.3333	-	X1G004481003300	X1G004481026900
40	-	X1G004481001500	X1G004481027000
48	X1G004481022600	X1G004481001100	X1G004481027100
50	X1G004481011200	X1G004481001200	X1G004481016000
72	X1G004481027200	X1G004481018300	X1G004481027300

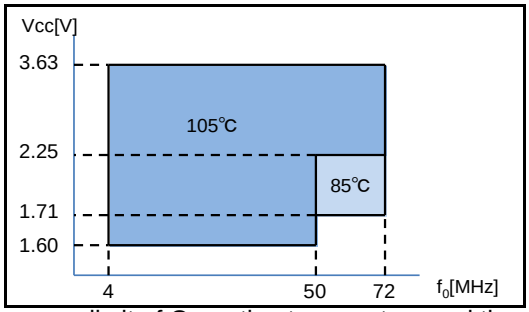
[2] Absolute Maximum Ratings

Parameter	Symbol	Specification			Unit	Conditions
		Min.	Typ.	Max.		
Maximum supply voltage	V_{CC}	-0.3	-	4	V	
Input voltage	Vin	-0.3	-	V_{CC} + 0.3	V	$\overline{ST}$ terminal
Storage temperature range	T_stg	-55	-	+125	ºC	SG2016CAN
		-40	-	+125	ºC	All other

[3] Operating Range

Parameter	Symbol	Specification			Unit	Conditions
		Min.	Typ.	Max.		
Supply voltage	V_{CC}	1.6	-	3.63	V	fo ≤ 50 MHz, T_use = +105 °C Max.
		1.71	-	3.63	V	fo = 72 MHz, T_use = +85 °C Max.
		2.25	-	3.63	V	fo = 72 MHz, T_use = +105 °C Max.
Supply voltage	GND	0.0	0.0	0.0	V	
Operating temperature range (Refer to Figure 1)	T_use	-20	+25	+70	ºC	
		-40	+25	+85	ºC	
		-40	+25	+105	ºC	
CMOS load condition	L_CMOS	-	-	15	pF	

* Power supply startup time (0 %V_{CC} → 90 %V_{CC}) should be more than 150 µs
* A 0.01 µF to a 0.1 µF bypass capacitor should be connected between V_{CC} and GND pins located close to the device



Please note that Supply voltage range (V_{CC}) depends on Output frequency(fo) and upper limit of Operating temperature(T_use Max.).

Figure 1: The upper limit of Operating temperature and the related conditions

[4] Frequency Characteristics

(Unless stated otherwise [3] Operating Range)

Parameter	Symbol	Specification			Unit	Conditions
		Min.	Typ.	Max.		
Output frequency	fo	4, 8, 10, 12, 12.288, 14.7456, 16, 20, 24, 24.576, 25, 26, 27, 32, 33.33, 33.3333, 40, 48, 50, 72			MHz	
Frequency tolerance *1	f_tol	-50	-	+50	$\times 10^{-6}$	T_use = -20 ºC to +70 ºC
		-100		+100	$\times 10^{-6}$	T_use = -40 ºC to +105 ºC T_use = -40 ºC to +85 ºC *2
Frequency aging	f_age	-3		+3	$\times 10^{-6}$	+25 ºC, First year

*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage change and load drift.
*2 This temperature range is only for fo = 75 MHz

[5] Electrical Characteristics (Unless stated otherwise [3] Operating Range)

Parameter	Symbol	Specification			Unit	Conditions
		Min.	Typ.	Max.		
Start-up time	t_str	-	-	3	ms	t = 0 at 90 %V_{CC}
Current consumption (No load) V_{CC} = 1.8 V ± 10 %	I_{CC}	-	-	1.5	mA	1 MHz ≤ fo ≤ 20 MHz
		-	-	1.8	mA	20 MHz < fo ≤ 40 MHz
		-	-	2.1	mA	40 MHz < fo ≤ 50 MHz
V_{CC} = 1.8 V ± 5 %		-	-	2.4	mA	fo = 72 MHz
Current consumption (No load) V_{CC} = 2.5 V ± 10 %		-	-	1.6	mA	1 MHz ≤ fo ≤ 20 MHz
		-	-	2.0	mA	20 MHz < fo ≤ 40 MHz
		-	-	2.4	mA	40 MHz < fo ≤ 50 MHz
		-	-	2.8	mA	fo = 72 MHz
Current consumption (No load) V_{CC} = 3.3 V ± 10 %		-	-	1.8	mA	1 MHz ≤ fo ≤ 20 MHz
		-	-	2.2	mA	20 MHz < fo ≤ 40 MHz
		-	-	2.6	mA	40 MHz < fo ≤ 50 MHz
		-	-	3.0	mA	fo = 72 MHz
Stand-by current	I_std	-	-	2.1	µA	V_{CC} = 1.8 V ± 10 % or ± 5 %, $\overline{ST}$ = GND
		-	-	2.5	µA	V_{CC} = 2.5 V ± 10 %, $\overline{ST}$ = GND
		-	-	2.7	µA	V_{CC} = 3.3 V ± 10 %, $\overline{ST}$ = GND
Output voltage	V_{OH}	90 % V_{CC}	-	-	V	Load current condition: 1.8 V ± 10 % / 2.5 V ± 10 % / 3.3 V ± 10 %; I_{OH} -1.5 mA / -3 mA / -4 mA; I_{OL} 1.5 mA / 3 mA / 4 mA
	V_{OL}	-	-	10 % V_{CC}	V	
	V_{OH}	V_{CC} - 0.4	-	-	V	Load current condition: 1.8 V ± 10 % / 2.5 V ± 10 % / 3.3 V ± 10 %; I_{OH} -1.5 mA / -3 mA / -4 mA; I_{OL} 1.5 mA / 3 mA / 4 mA
	V_{OL}	-	-	0.4	V	
Symmetry	SYM	45	50	55	%	50 % V_{CC} level, L_CMOS ≤ 15 pF
Rise time / Fall time	tr / tf	-	-	3	ns	V_{CC} = 2.5 V or 3.3 V ± 10 %, 20 % V_{CC} to 80 % V_{CC} Level, L_CMOS = 15 pF
		-	-	3.5	ns	V_{CC} = 1.8 V ± 10 % or ± 5 %, 20 % V_{CC} to 80 % V_{CC} Level, L_CMOS = 15 pF
Input voltage	V_{IH}	80 % Vcc	-	-	V	$\overline{ST}$ terminal
	V_{IL}	-	-	20 % Vcc	V	
Output disable time (ST)	tstp_st	-	-	100	ns	$\overline{ST}$ terminal HIGH → LOW
Output enable time (ST)	tsta_st	-	-	3	ms	$\overline{ST}$ terminal LOW → HIGH

[6] Thermal resistance (For reference only)

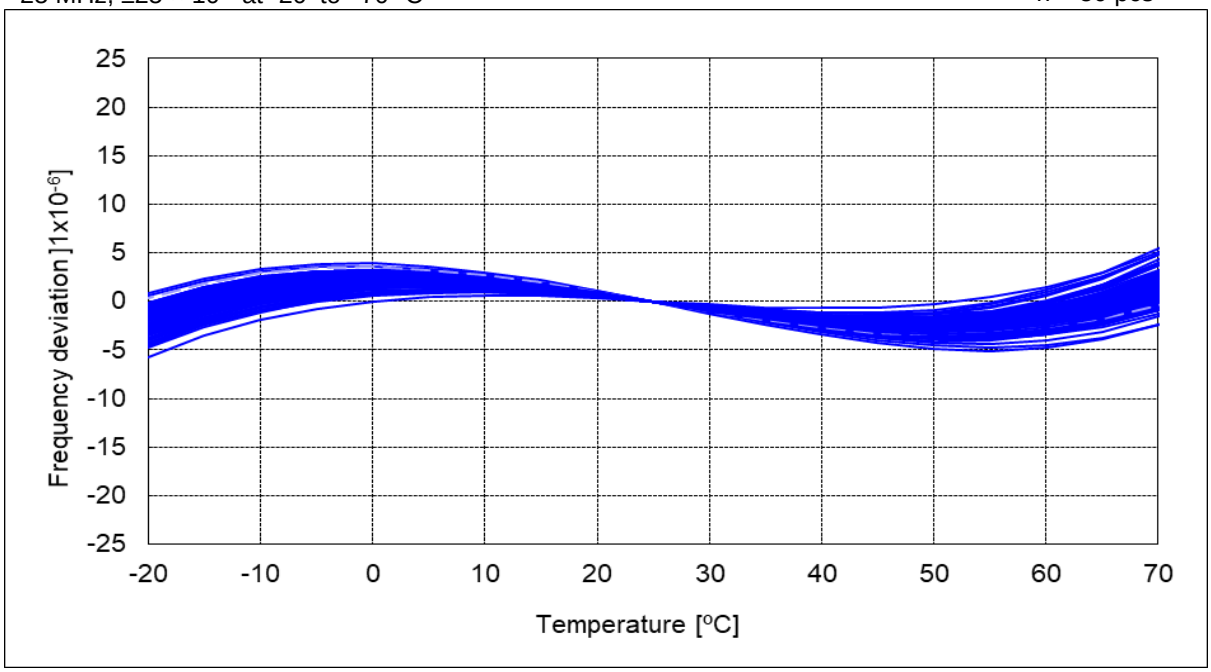
Parameter	Symbol	Specification			Unit	Conditions
		Min.	Typ.	Max.		
Junction temperature	Tj	-	-	+125	ºC	
Junction to case	θjc	-	10	-	ºC/W	SG2016CAN
		-	15	-	ºC/W	SG-210STF
		-	28	-	ºC/W	SG3225CAN
		-	16	-	ºC/W	SG5032CAN
		-	23	-	ºC/W	SG7050CAN
Junction to ambient	θja	-	100	-	ºC/W	SG2016CAN
		-	92	-	ºC/W	SG-210STF
		-	79	-	ºC/W	SG3225CAN
		-	82	-	ºC/W	SG5032CAN
		-	104	-	ºC/W	SG7050CAN

[7] Typical Performance Characteristics (For reference only)

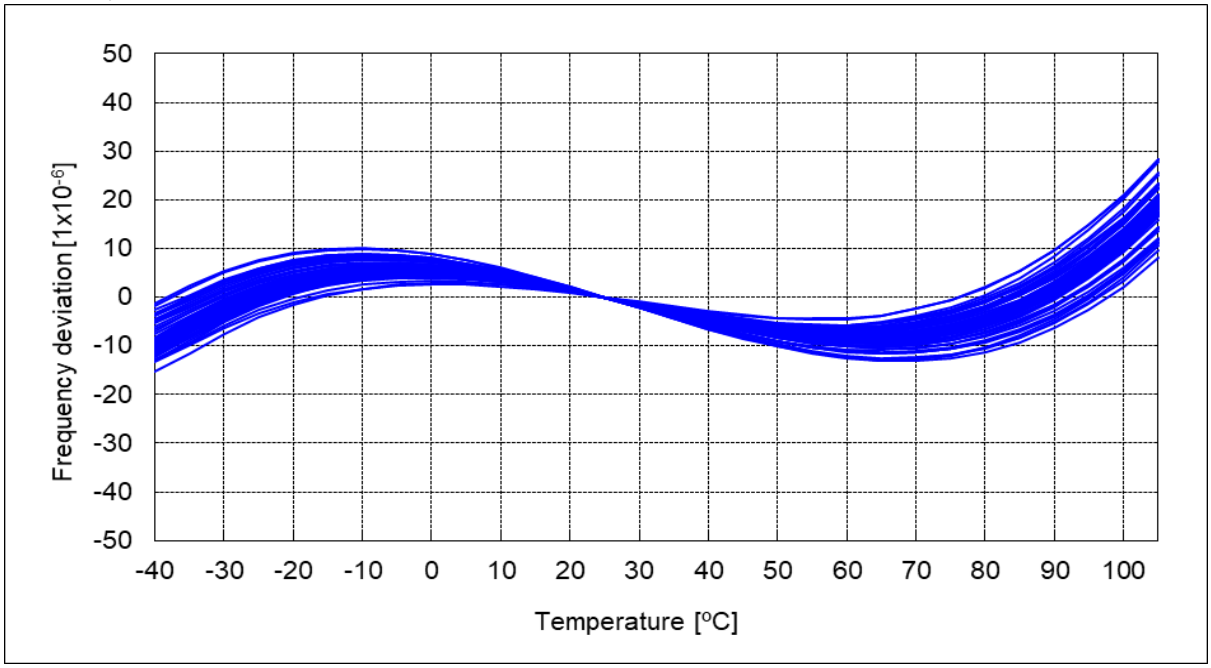
The following data shows typical performance characteristics

(7-1) Frequency / Temperature Characteristics

fo = 25 MHz, ±25 × 10^{-6} at -20 to +70 ºC n = 50 pcs

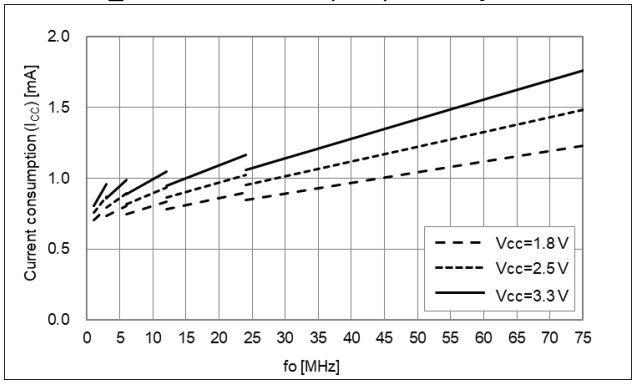


fo = 25 MHz, ±50 × 10^{-6} at -40 to +85 ºC/+105 ºC n = 50 pcs

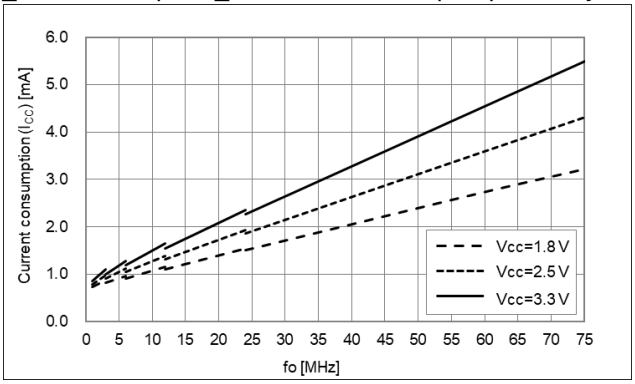


(7-2) Current Consumption

No load, T_use = +25 ºC, Freq. Dependency

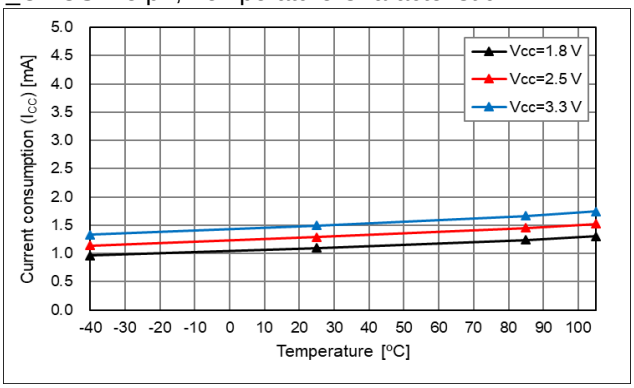


L_CMOS = 15 pF, T_use = +25 ºC, Freq. Dependency

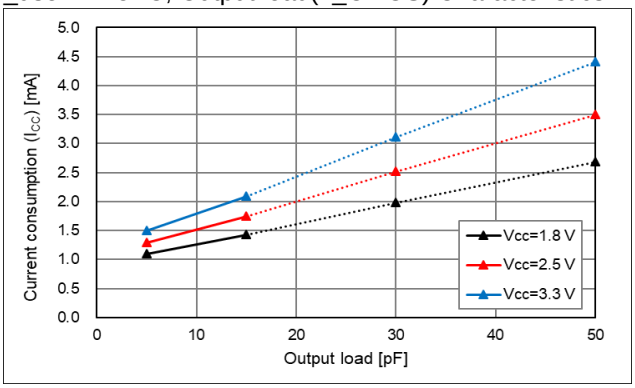


fo = 20 MHz

L_CMOS = 5 pF, Temperature Characteristic

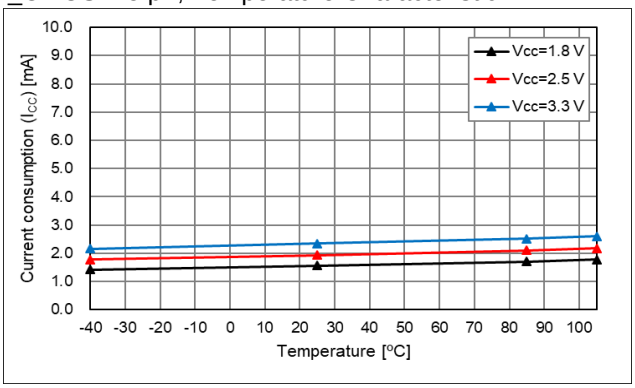


T_use = +25 ºC, Output load(L_CMOS) Characteristics

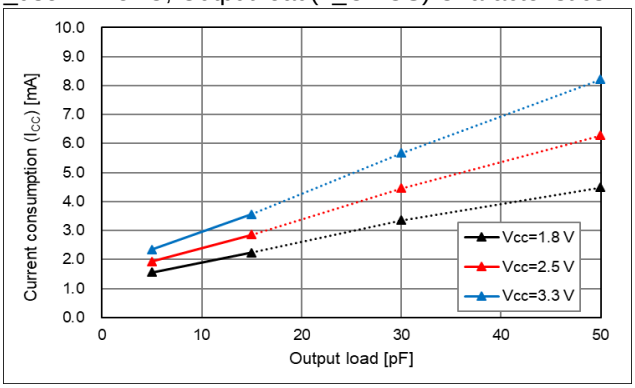


fo = 40 MHz

L_CMOS = 5 pF, Temperature Characteristic

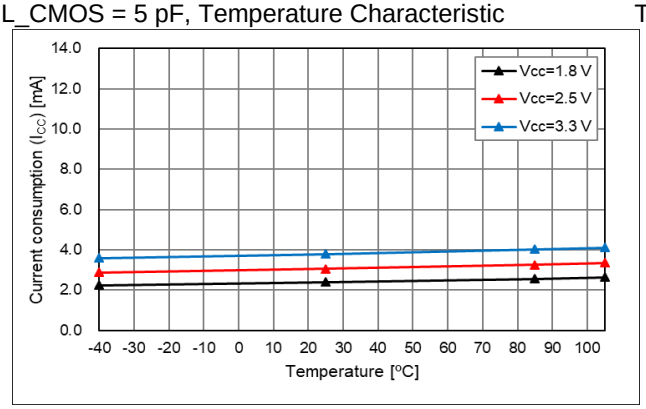


T_use = +25 ºC, Output load(L_CMOS) Characteristics

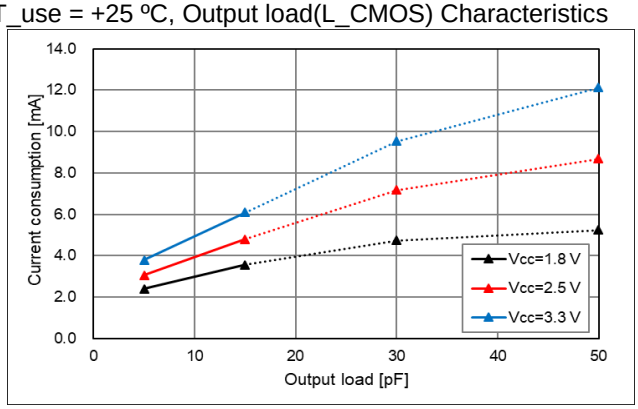


fo = 72 MHz

L_CMOS = 5 pF, Temperature Characteristic



T_use = +25 ºC, Output load(L_CMOS) Characteristics



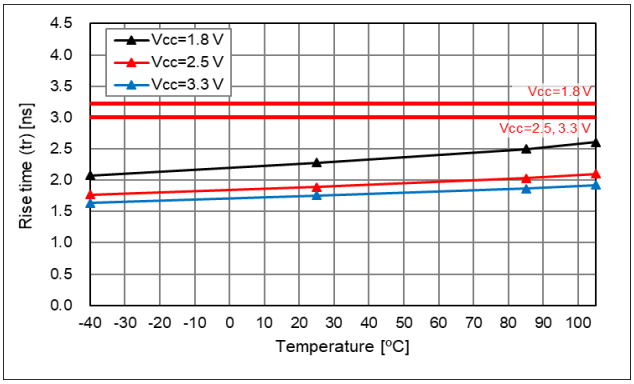
* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

The actual current consumption is the total of the current under the condition of no load and the current to drive the output load (fo × L_CMOS × V_{CC}). To reduce the current consumption, it is effective to use lower frequency, lower supply voltage and lower output load.

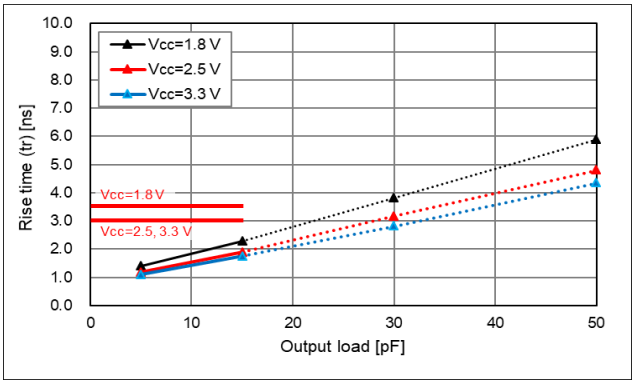
(7-3) Rise Time / Fall Time

fo = 20 MHz, Rise Time

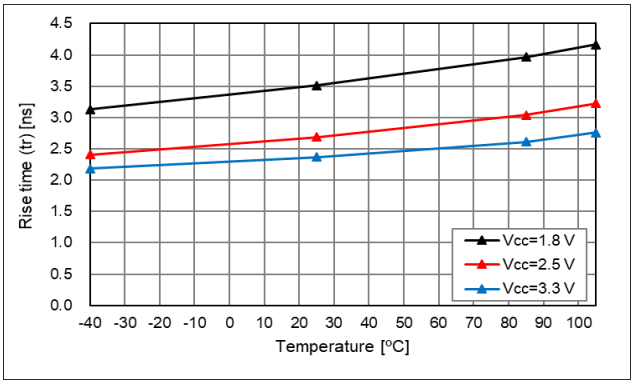
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



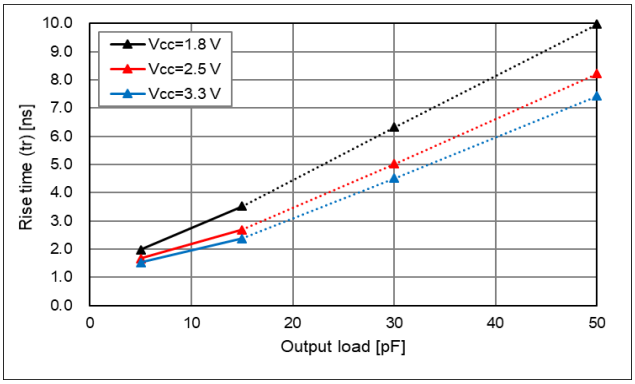
20 % - 80 %V_{CC}, T_use = +25 ºC, Output load Char.



10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



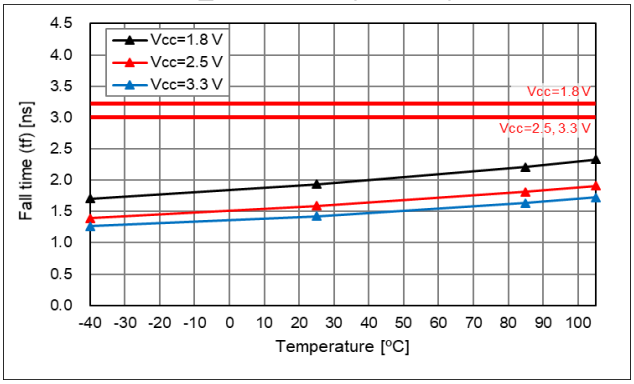
10 % - 90 %V_{CC}, T_use = +25 ºC, Output load Char.



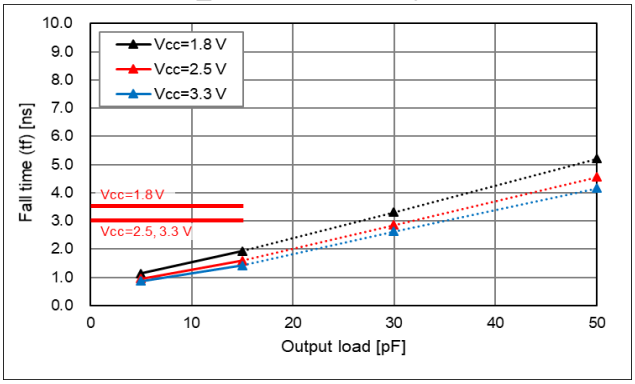
* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

fo = 20 MHz, Fall Time

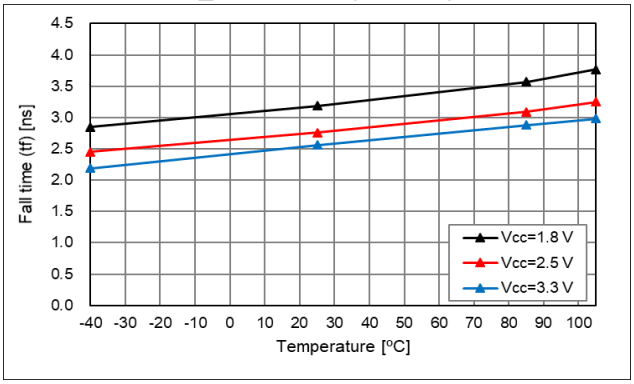
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



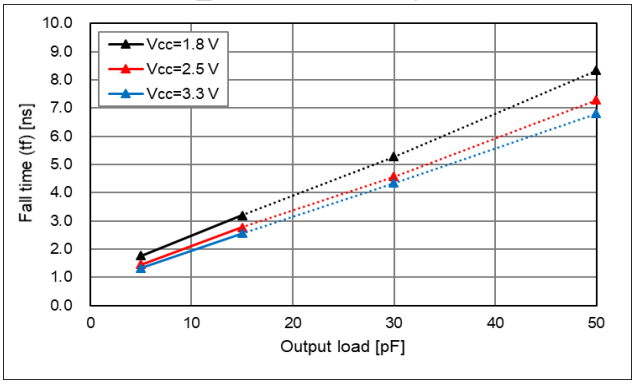
20 % - 80 %V_{CC}, T_use = +25 ºC, Output load Char.



10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



10 % - 90 %V_{CC}, T_use = +25 ºC, Output load Char.

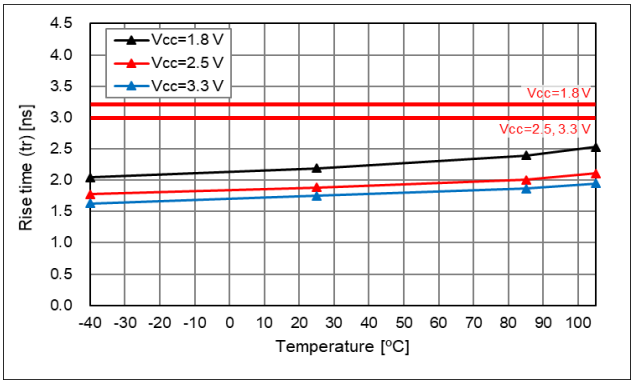


* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

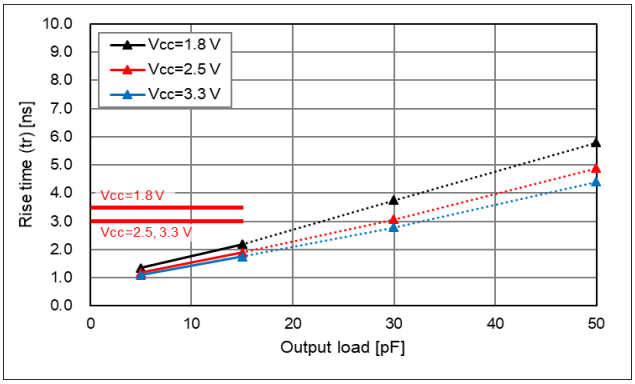
(7-3) Rise Time / Fall Time [cont'd]

fo = 40 MHz, Rise Time

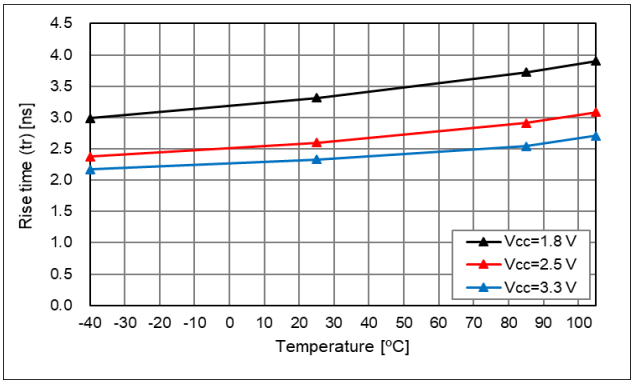
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



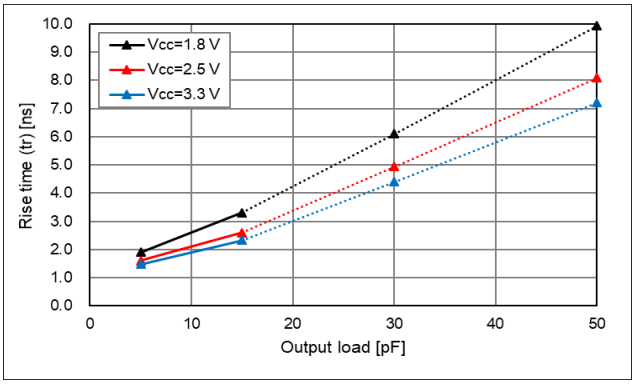
20 % - 80 %V_{CC}, T_use = +25 ºC, Output load Char.



10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



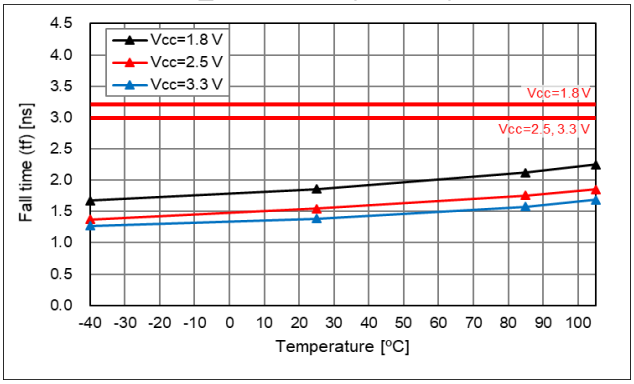
10 % - 90 %V_{CC}, T_use = +25 ºC, Output load Char.



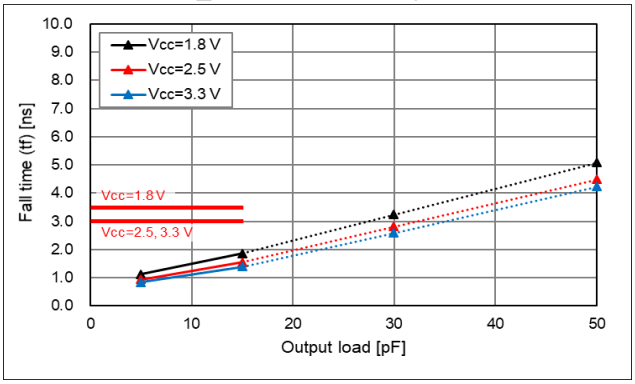
* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

fo = 40 MHz, Fall Time

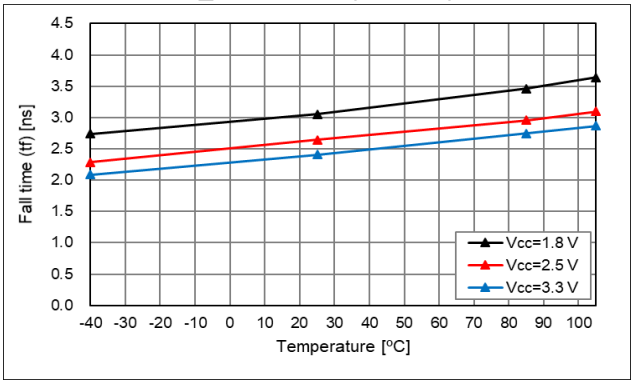
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



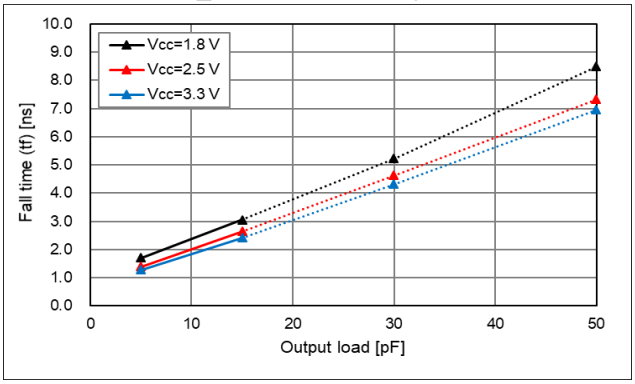
20 % - 80 %V_{CC}, T_use = +25 ºC, Output load Char.



10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



10 % - 90 %V_{CC}, T_use = +25 ºC, Output load Char.

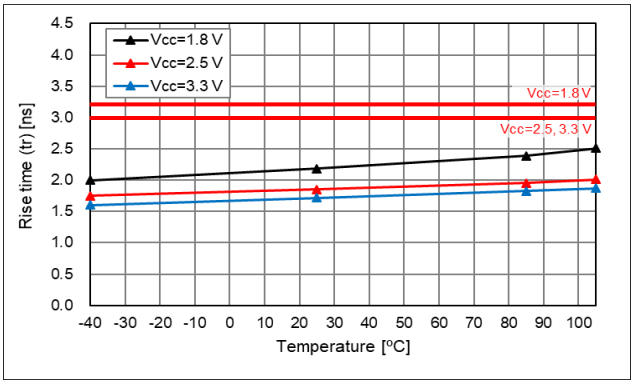


* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

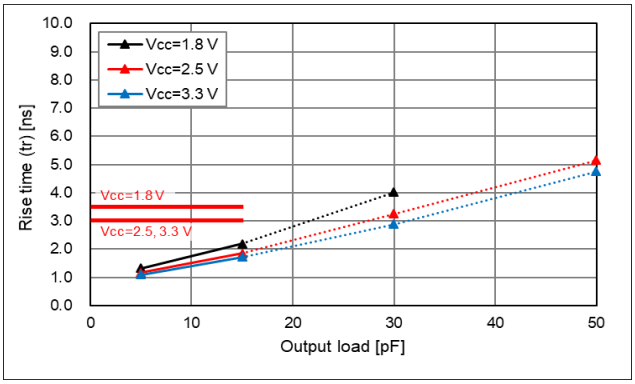
(7-3) Rise Time / Fall Time [cont'd]

fo = 72 MHz, Rise Time

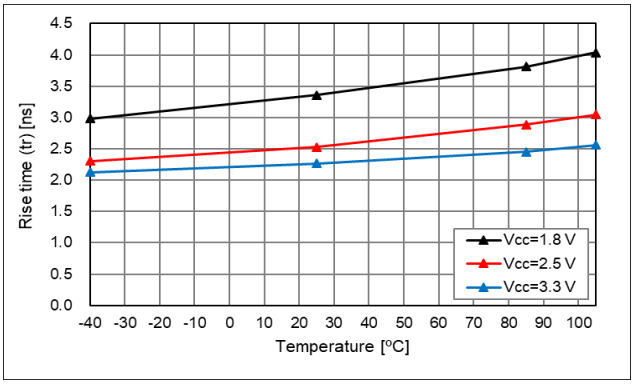
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



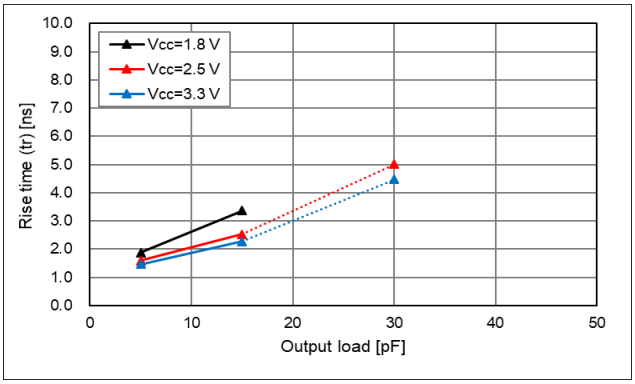
20 % - 80 %V_{CC}, T_use = +25 ºC, Output load Char.



10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



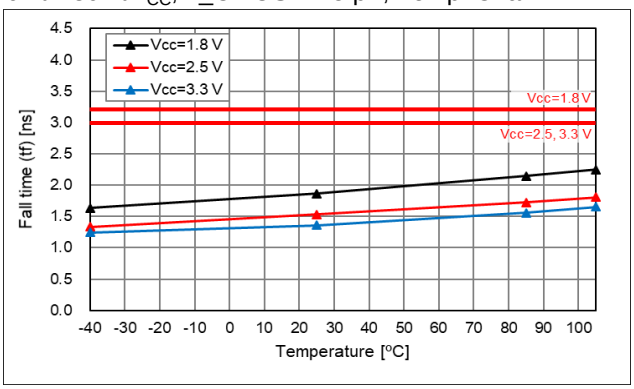
10 % - 90 %V_{CC}, T_use = +25 ºC, Output load Char.



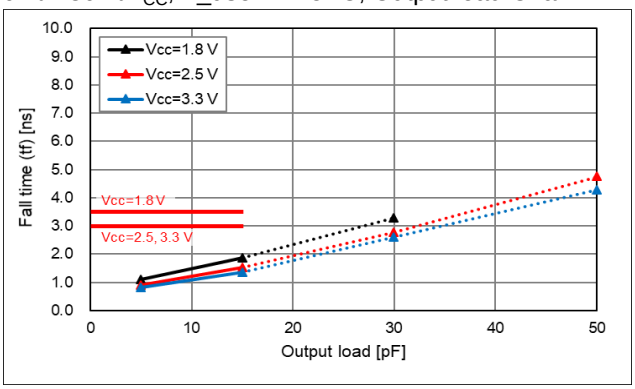
* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.
There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of L_CMOS > 15 pF.

fo = 72 MHz, Fall Time

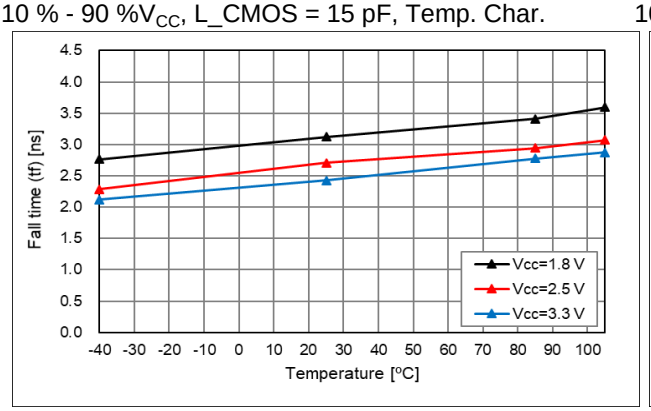
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



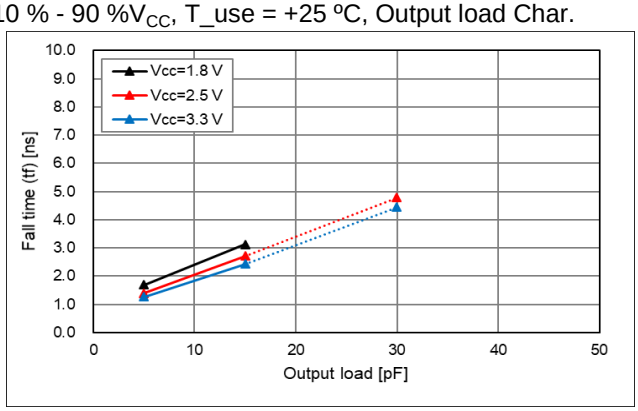
20 % - 80 %V_{CC}, T_use = +25 ºC, Output load Char.



10 % - 90 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



10 % - 90 %V_{CC}, T_use = +25 ºC, Output load Char.

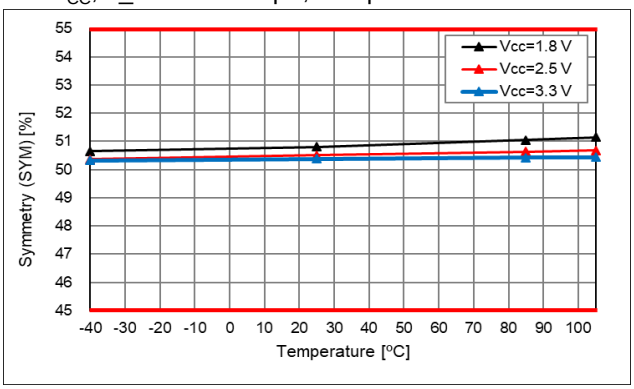


* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.
There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of L_CMOS > 15 pF.

(7-4) Symmetry

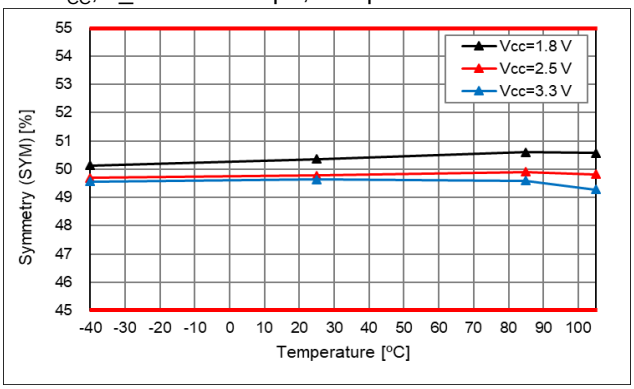
fo = 20 MHz

50 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



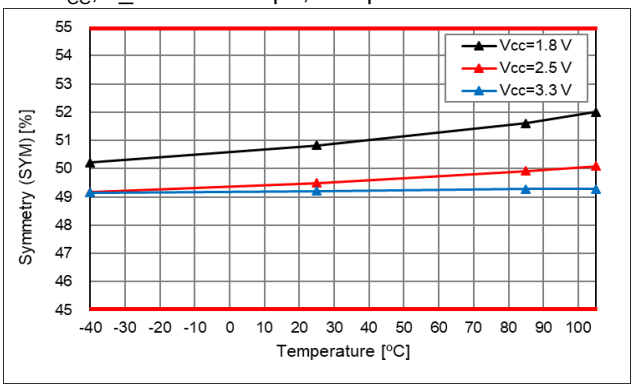
fo = 40 MHz

50 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



fo = 72 MHz

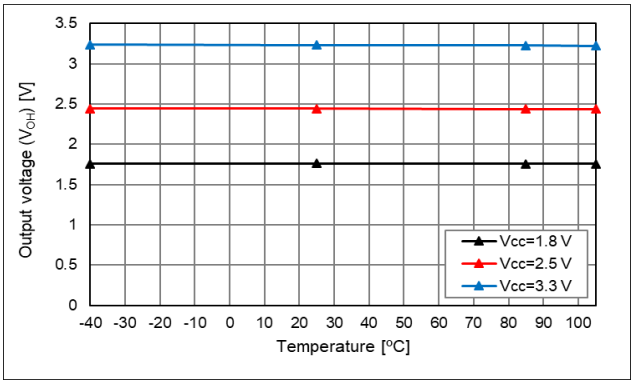
50 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



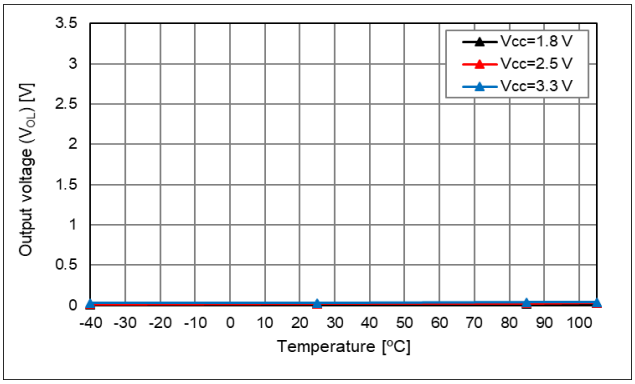
(7-5) Output Voltage

fo = 20 MHz

V_{OH}, L_CMOS = 15 pF, Temp. Char.

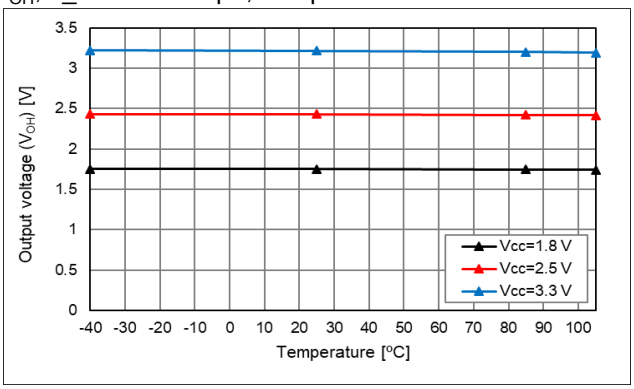


V_{OL}, L_CMOS = 15 pF, Temp. Char.

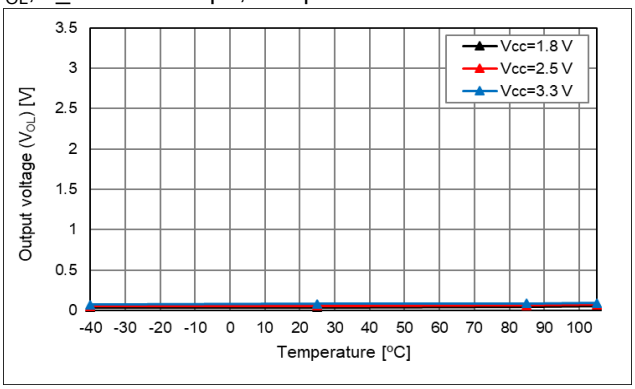


fo = 40 MHz

V_{OH}, L_CMOS = 15 pF, Temp. Char.

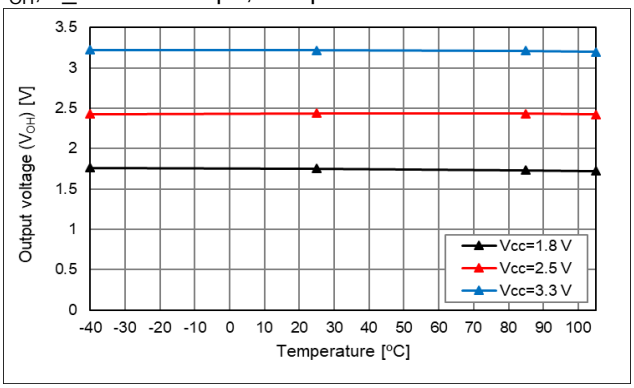


V_{OL}, L_CMOS = 15 pF, Temp. Char.

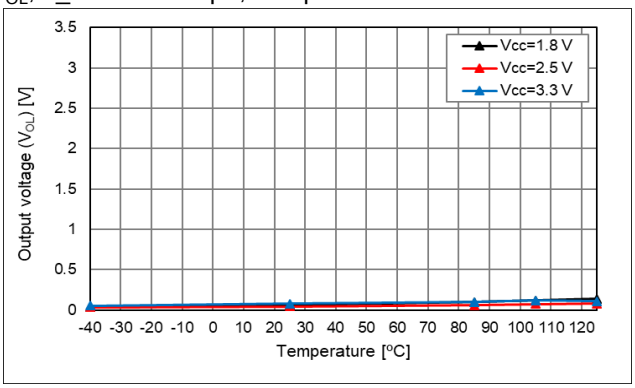


fo = 72 MHz

V_{OH}, L_CMOS = 15 pF, Temp. Char.



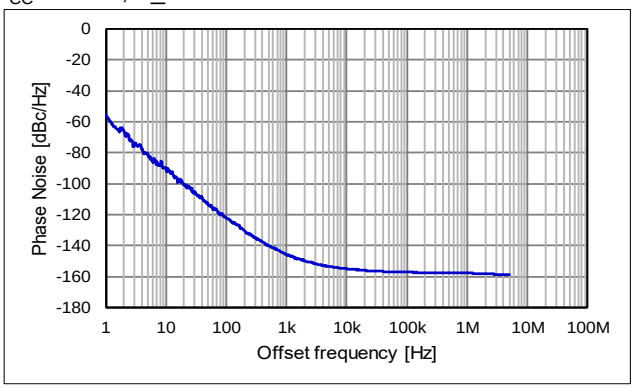
V_{OL}, L_CMOS = 15 pF, Temp. Char.



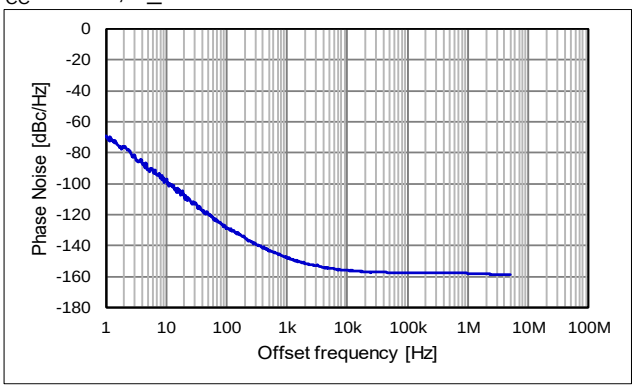
(7-6) Phase Noise, Phase Jitter, and Jitter

fo = 20 MHz

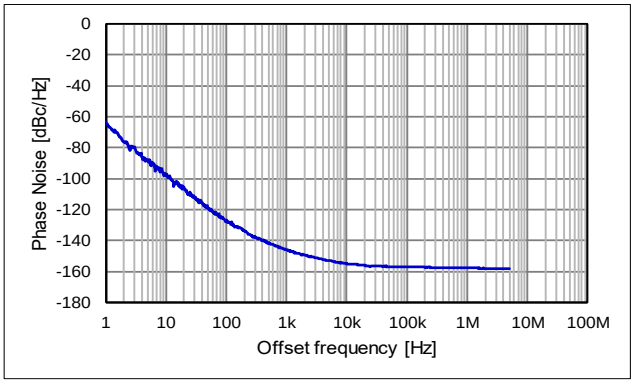
V_{CC} = 3.3 V, T_use = +25 ºC



V_{CC} = 2.5 V, T_use = +25 ºC



V_{CC} = 1.8 V, T_use = +25 ºC



Phase Jitter (Offset frequency: 12 kHz to 5 MHz)

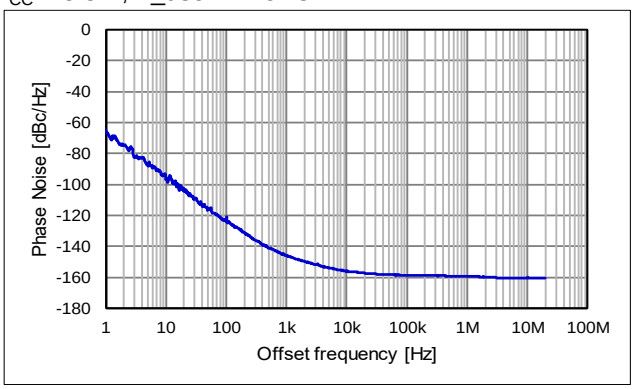
V_{CC}	Phase Jitter
3.3 V	0.31 ps
2.5 V	0.31 ps
1.8 V	0.32 ps

Jitter (T_use = +25 ºC, V_{CC} = 3.3 V)

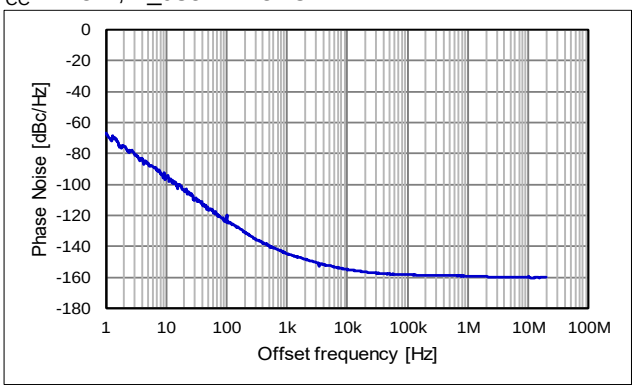
Total jitter (BER = 10^{-12})	31.3 ps
RMS jitter	1.8 ps
Peak to peak jitter	15 ps

fo = 40 MHz

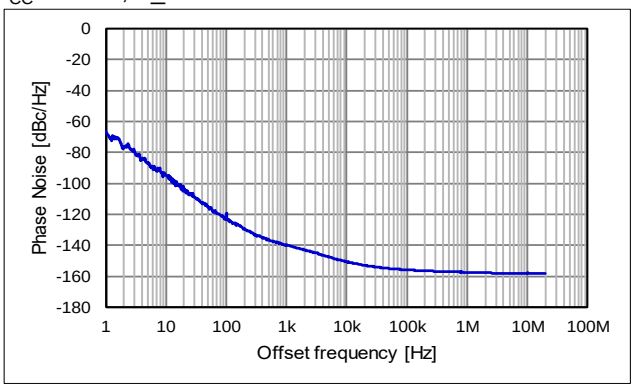
V_{CC} = 3.3 V, T_use = +25 ºC



V_{CC} = 2.5 V, T_use = +25 ºC



V_{CC} = 1.8 V, T_use = +25 ºC



Phase Jitter (Offset frequency: 12 kHz to 20 MHz)

V_{CC}	Phase Jitter
3.3 V	0.24 ps
2.5 V	0.26 ps
1.8 V	0.32 ps

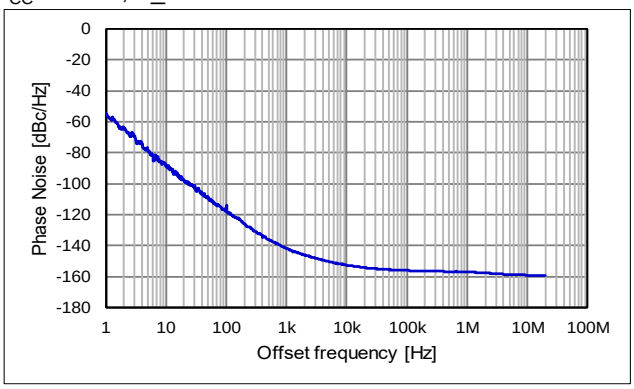
Jitter (T_use = +25 ºC, V_{CC} = 3.3 V)

Total jitter (BER = 10^{-12})	22.3 ps
RMS jitter	1.8 ps
Peak to peak jitter	16 ps

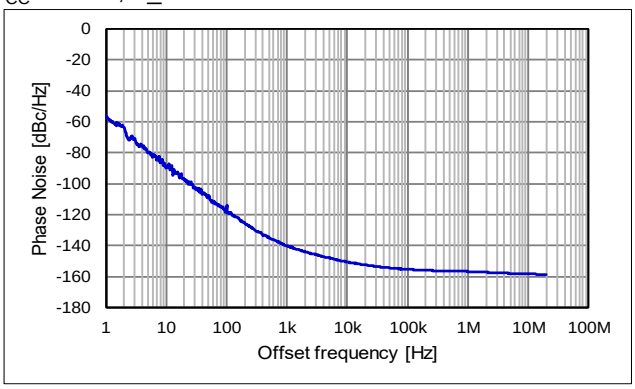
(7-6) Phase Noise and Phase Jitter [cont'd]

fo = 72 MHz

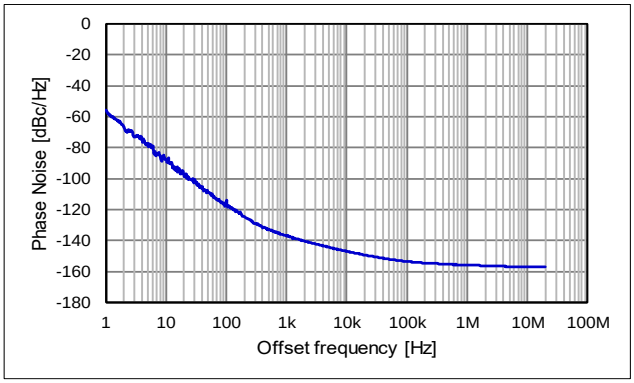
V_{CC} = 3.3 V, T_use = +25 ºC



V_{CC} = 2.5 V, T_use = +25 ºC



V_{CC} = 1.8 V, T_use = +25 ºC



Phase Jitter (Offset frequency: 12 kHz to 20 MHz)

V_{CC}	Phase Jitter
3.3 V	0.16 ps
2.5 V	0.17 ps
1.8 V	0.20 ps

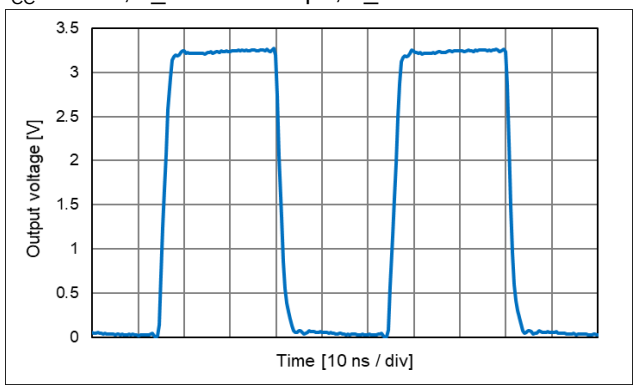
Jitter (T_use = +25 ºC, V_{CC} = 3.3 V)

Total jitter (BER = 10^{-12})	21.8 ps
RMS jitter	1.8 ps
Peak to peak jitter	16 ps

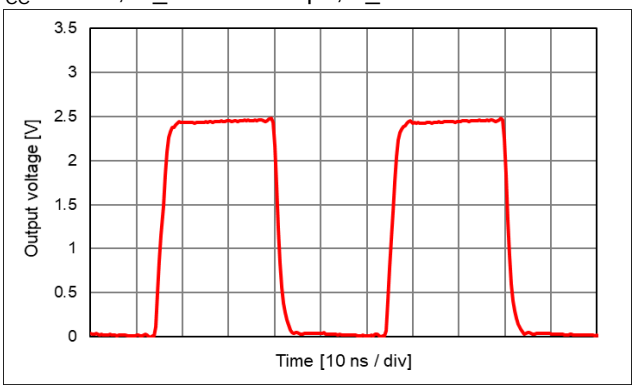
(7-7) Output Waveform

fo = 20 MHz

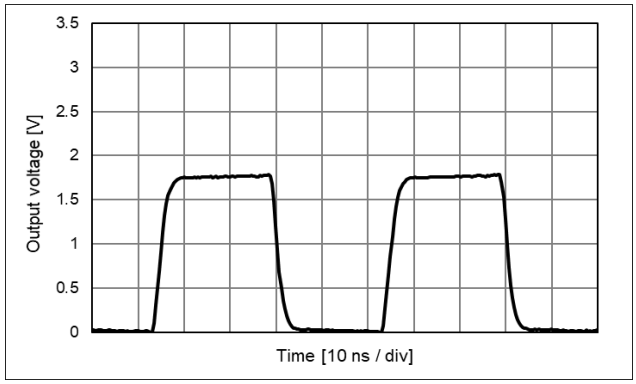
V_{CC} = 3.3 V, L_CMOS = 15 pF, T_use = +25 ºC



V_{CC} = 2.5 V, L_CMOS = 15 pF, T_use = +25 ºC

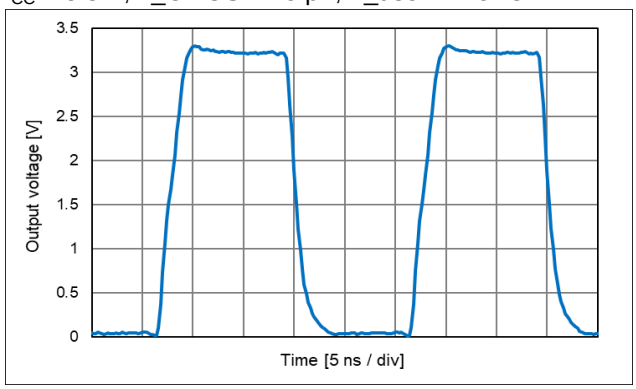


V_{CC} = 1.8 V, L_CMOS = 15 pF, T_use = +25 ºC

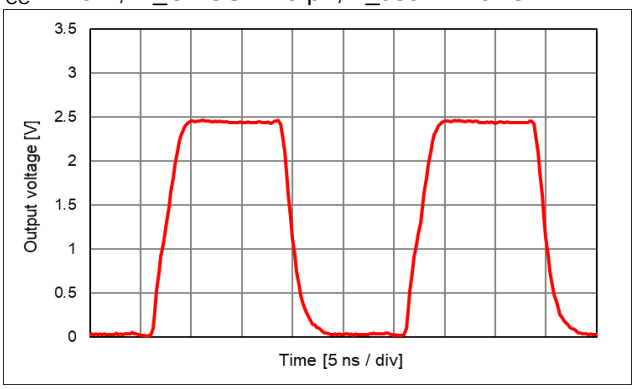


fo = 40 MHz

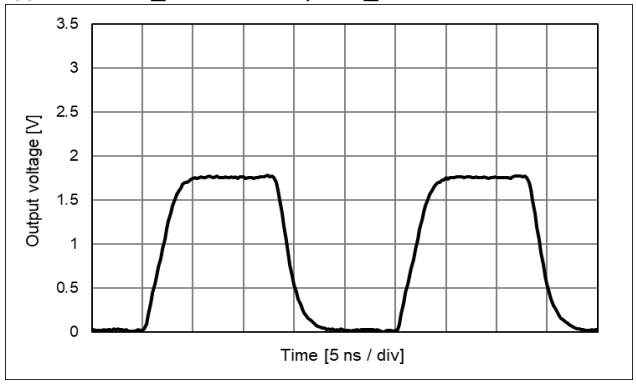
V_{CC} = 3.3 V, L_CMOS = 15 pF, T_use = +25 ºC



V_{CC} = 2.5 V, L_CMOS = 15 pF, T_use = +25 ºC



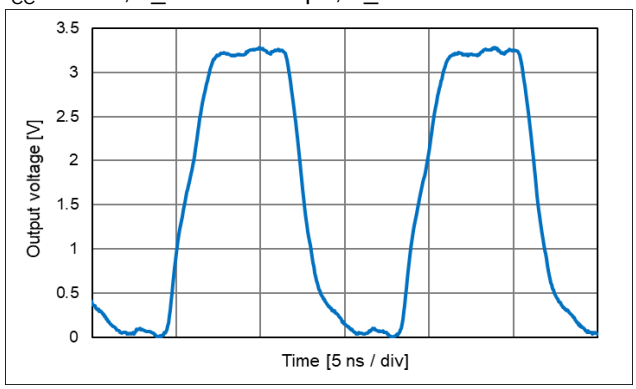
V_{CC} = 1.8 V, L_CMOS = 15 pF, T_use = +25 ºC



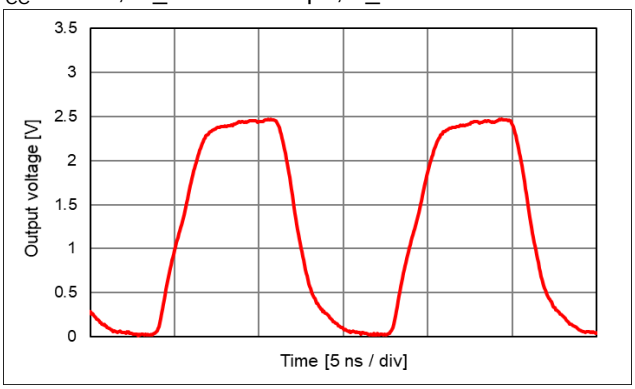
(7-7) Output Waveform [cont'd]

fo = 72 MHz

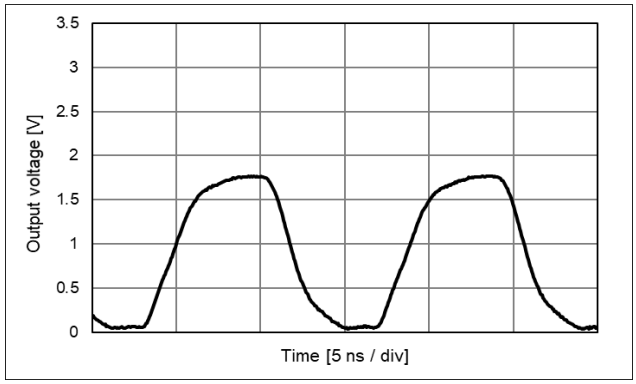
V_{CC} = 3.3 V, L_CMOS = 15 pF, T_use = +25 ºC



V_{CC} = 2.5 V, L_CMOS = 15 pF, T_use = +25 ºC

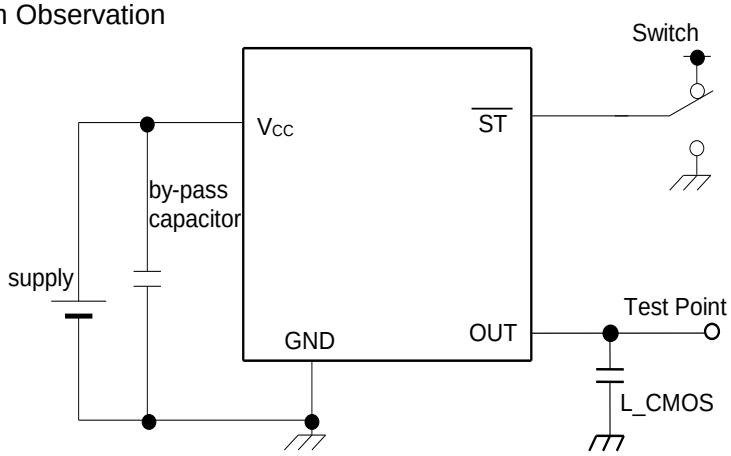


V_{CC} = 1.8 V, L_CMOS = 15 pF, T_use = +25 ºC

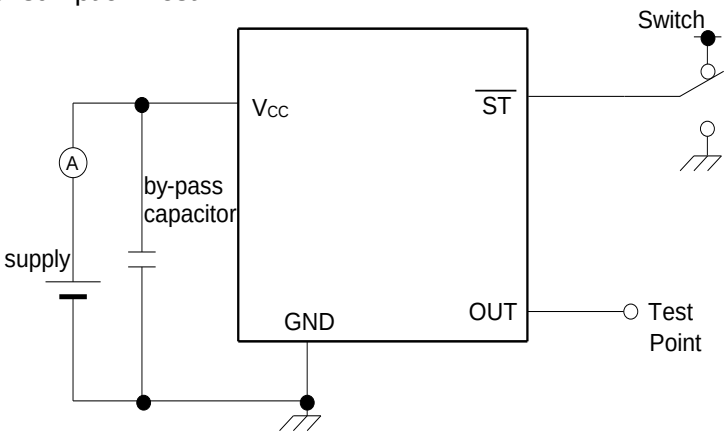


[8] Test Circuit

(8-1) Waveform Observation



(8-2) Current Consumption Test



*Standby current test should be $\overline{ST}$ = GND.

(8-3) Condition

(1) Oscilloscope

The bandwidth should be minimum 5 times wider than measurement frequency

The probe ground should be placed closely to the test point and the lead length should be as short as possible

* It is recommended to use miniature socket. (Don't use earth lead.)

(2) L_CMOS includes probe capacitance.

(3) A 0.01 µF to a 0.1 µF bypass capacitor should be connected between V_{CC} and GND pins located close to the device

(4) Use a current meter with a low internal impedance

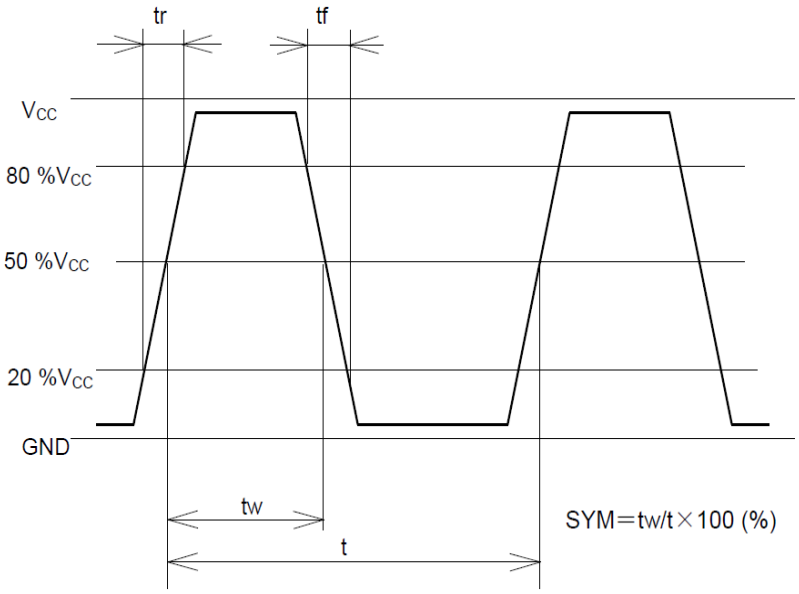
(5) Power Supply

Power supply startup time (0 %V_{CC} → 90 %V_{CC}) should be more than 150 µs

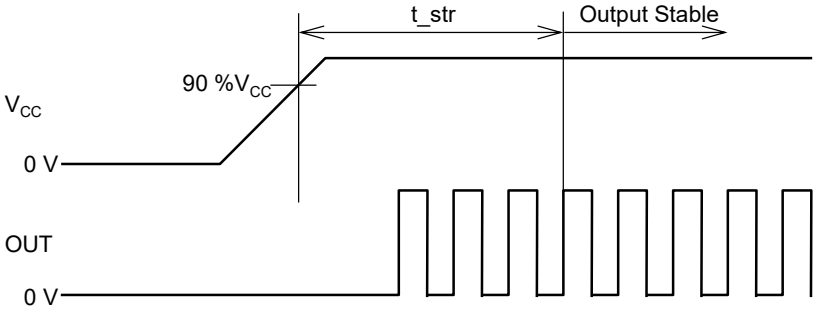
Power supply impedance should be as low as possible

(8-4) Timing Chart

(1) Output Waveform and Level

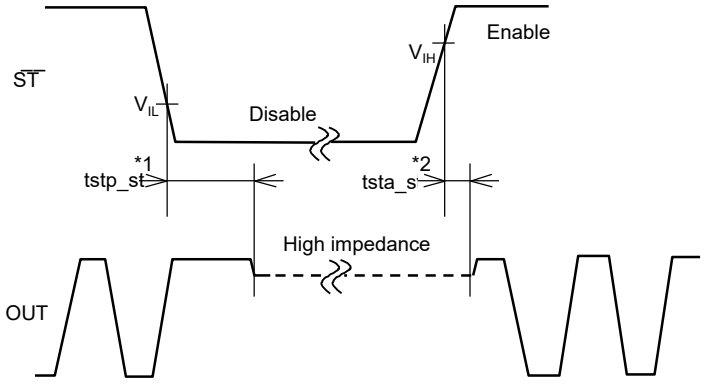


(2) Output Frequency Timing



(3) $\overline{ST}$ Function and Timing

$\overline{ST}$ Terminal	Osc. circuit	Output status
"H" or OPEN	Oscillation	Specified frequency: Enable
"L"	Oscillation stop	High impedance: Disable



*1 The period from $\overline{ST}$ = V_{IL} to OUT = High impedance (Disable)

*2 The period from $\overline{ST}$ = V_{IH} to OUT = Enable

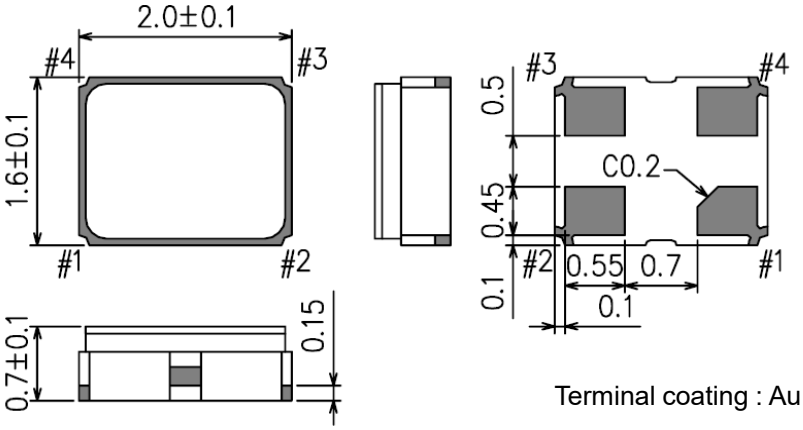
* Judge of starting output: $V_{OH} \geq 80\ \%V_{CC}$, $V_{OL} \leq 20\ \%Vcc$, fout is within fo ± 1 000 × 10^{-6}

* $\overline{ST}$ terminal voltage level should not exceed supply voltage when using $\overline{ST}$ function.
Please note that $\overline{ST}$ rise time should not exceed supply voltage rise time at the start-up.

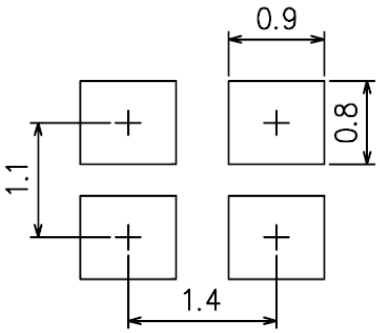
[9] Outline Drawing and Recommended Footprint

(9-1) SG2016CAN

Units: mm



Terminal coating : Au plating



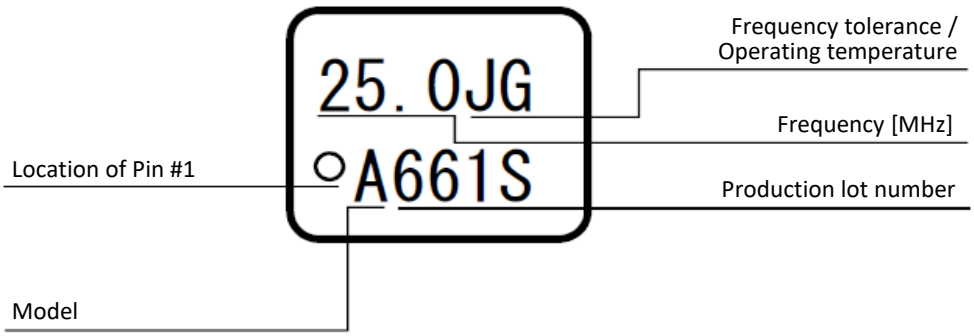
For stable operation, it is recommended that 0.01 µF to 0.1 µF bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 9.9 mg

Terminal Assignment

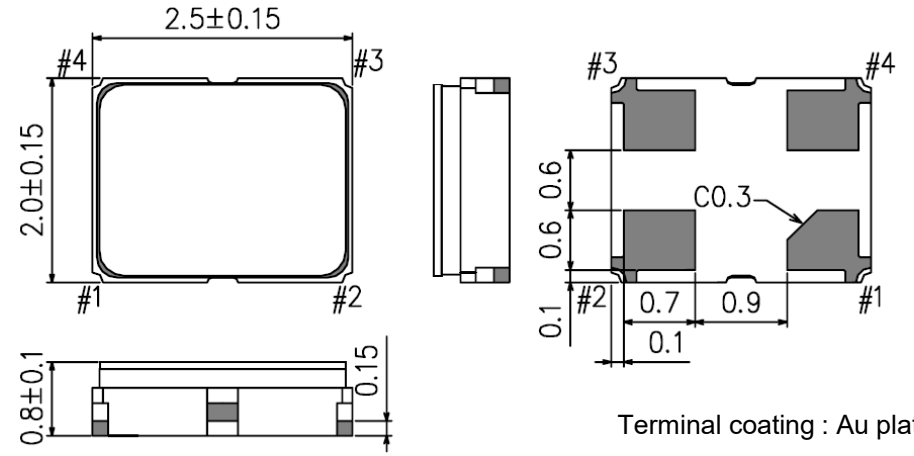
Pin #	Connection	Function		
#1	$\overline{ST}$	$\overline{ST}$ terminal		
		$\overline{ST}$ function	Osc. Circuit	Output
		"H" or OPEN	Oscillation	Specified frequency: Enable
		"L"	Oscillation stop	High impedance: Disable
#2	GND	GND terminal		
#3	OUT	Output terminal		
#4	V_{CC}	V_{CC} terminal		

Marking

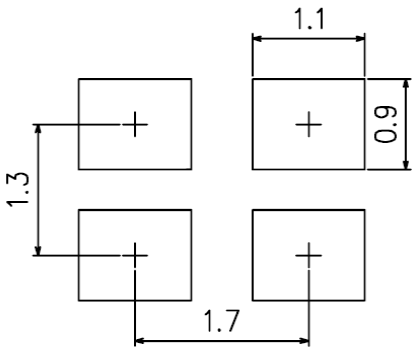


(9-2) SG-210STF

Units: mm



Terminal coating : Au plating



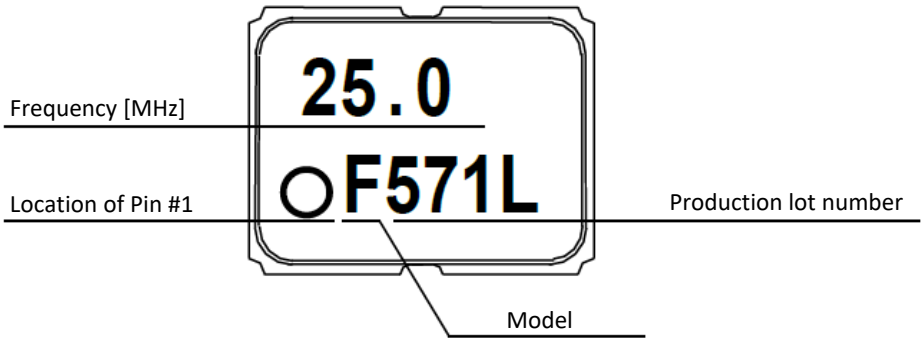
For stable operation, it is recommended that 0.01 µF to 0.1 µF bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 14 mg

Terminal Assignment

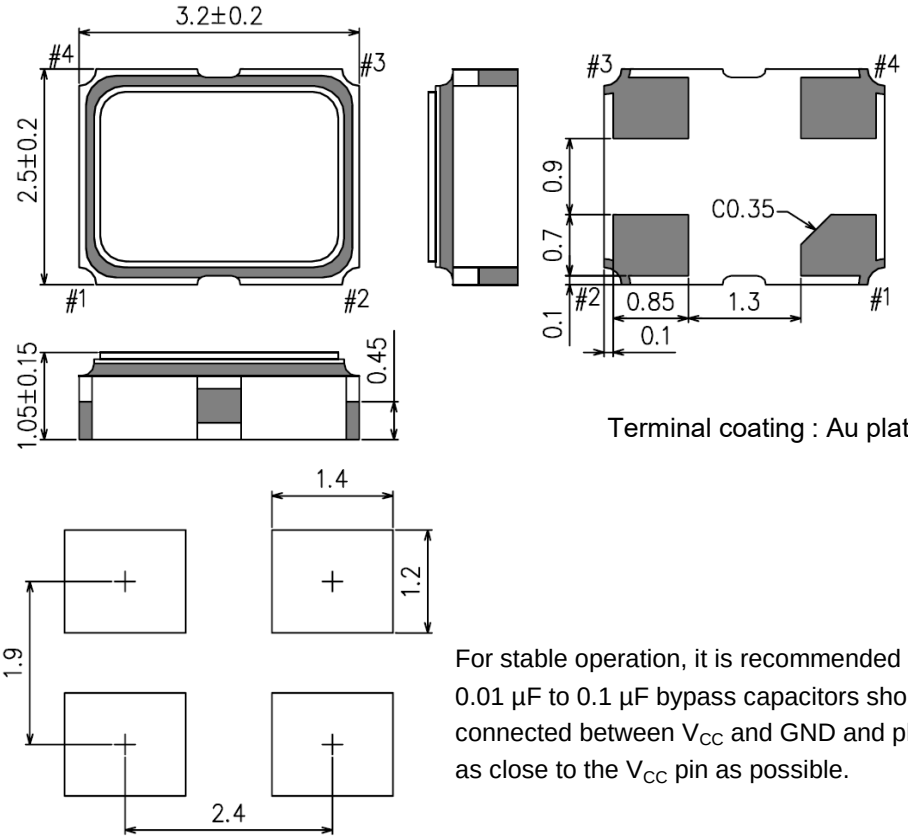
Pin #	Connection	Function		
#1	$\overline{ST}$	$\overline{ST}$ terminal		
		$\overline{ST}$ function	Osc. Circuit	Output
		"H" or OPEN	Oscillation	Specified frequency: Enable
		"L"	Oscillation stop	High impedance: Disable
#2	GND	GND terminal		
#3	OUT	Output terminal		
#4	V_{CC}	V_{CC} terminal		

Marking



(9-3) SG3225CAN

Units: mm



Terminal coating : Au plating

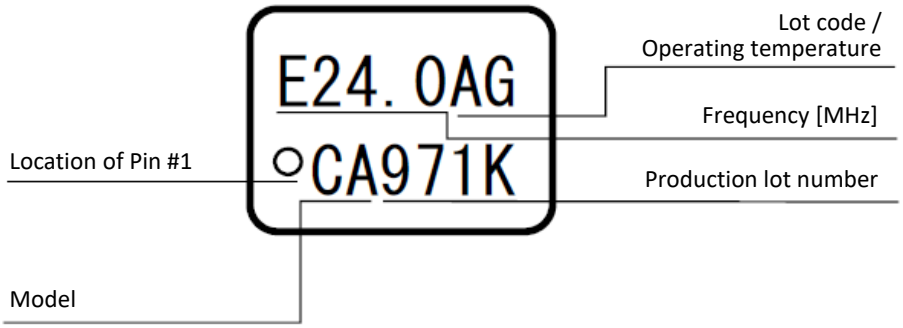
For stable operation, it is recommended that 0.01 µF to 0.1 µF bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 25 mg

Terminal Assignment

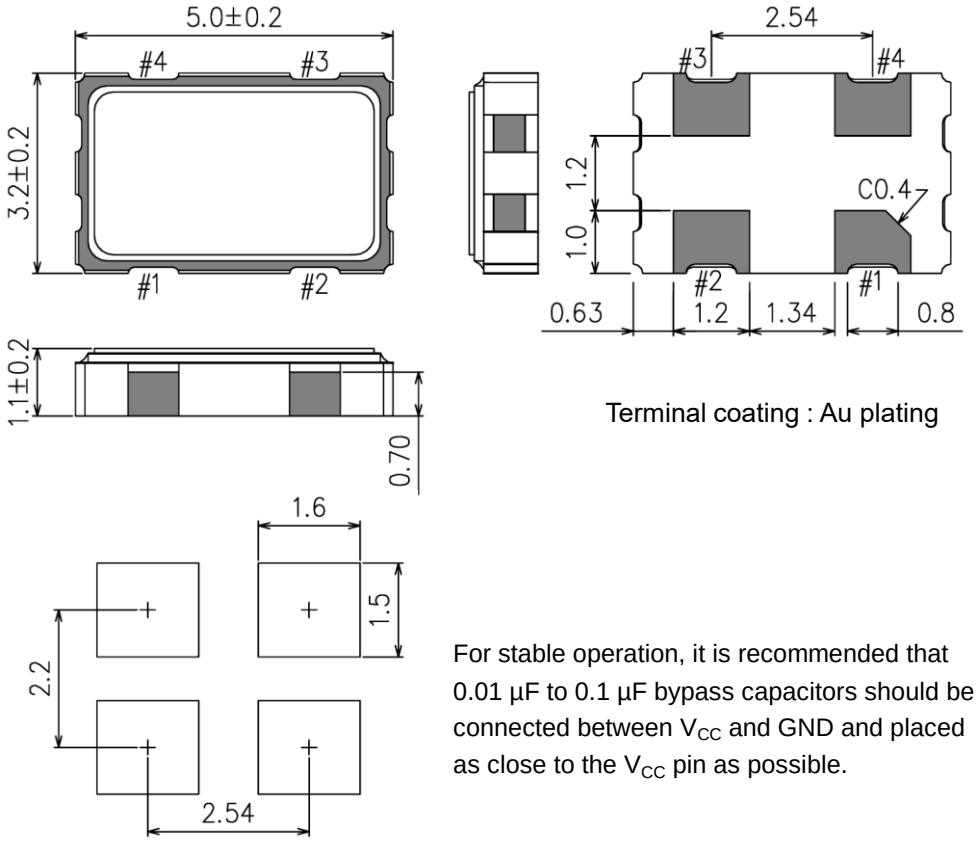
Pin #	Connection	Function		
#1	$\overline{ST}$	$\overline{ST}$ terminal		
		$\overline{ST}$ function	Osc. Circuit	Output
		"H" or OPEN	Oscillation	Specified frequency: Enable
		"L"	Oscillation stop	High impedance: Disable
#2	GND	GND terminal		
#3	OUT	Output terminal		
#4	V_{CC}	V_{CC} terminal		

Marking



(9-4) SG5032CAN

Units: mm



Terminal coating : Au plating

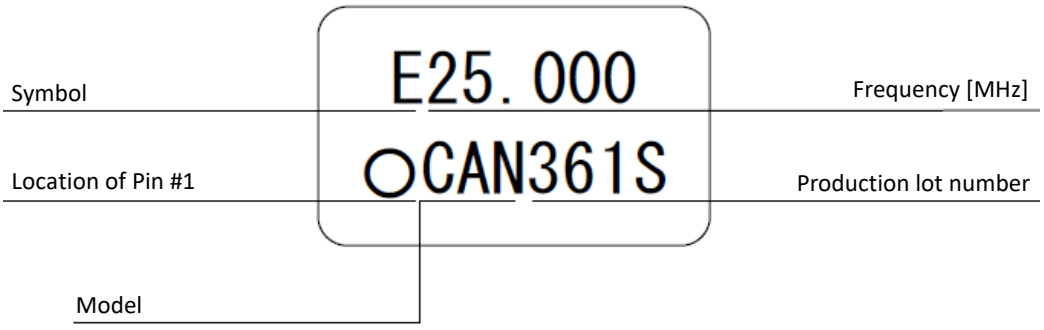
For stable operation, it is recommended that 0.01 µF to 0.1 µF bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 52 mg

Terminal Assignment

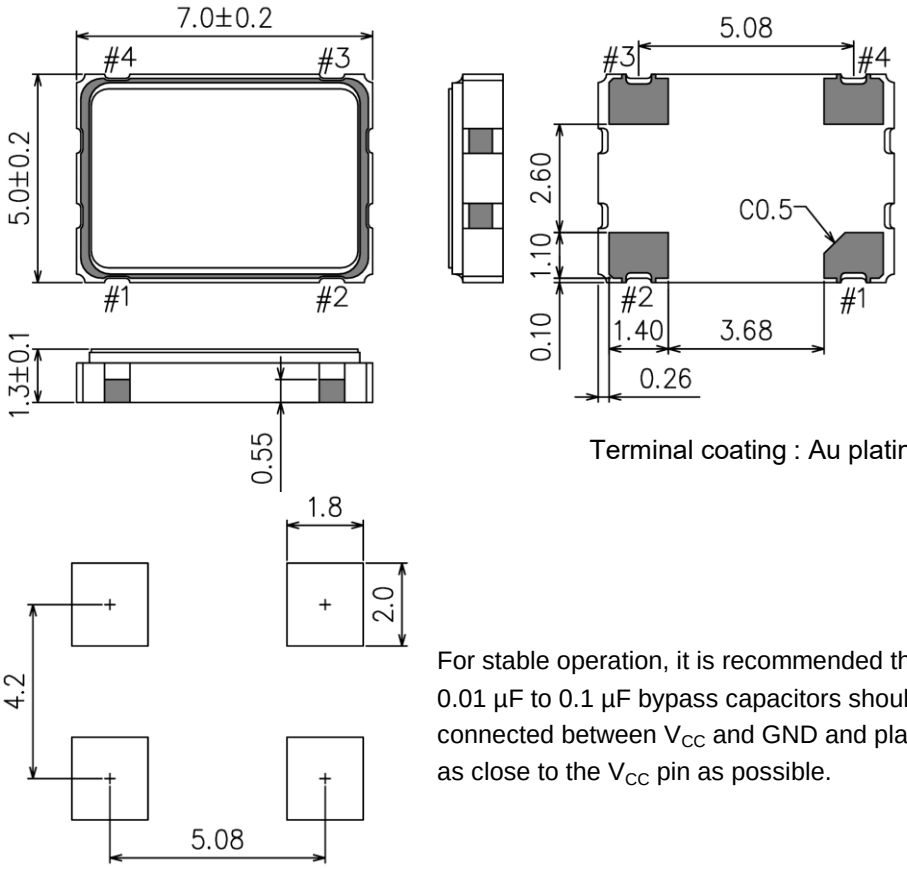
Pin #	Connection	Function		
#1	$\overline{ST}$	$\overline{ST}$ terminal		
		$\overline{ST}$ function	Osc. Circuit	Output
		"H" or OPEN	Oscillation	Specified frequency: Enable
		"L"	Oscillation stop	High impedance: Disable
#2	GND	GND terminal		
#3	OUT	Output terminal		
#4	V_{CC}	V_{CC} terminal		

Marking



(9-5) SG7050CAN

Units: mm



Terminal coating : Au plating

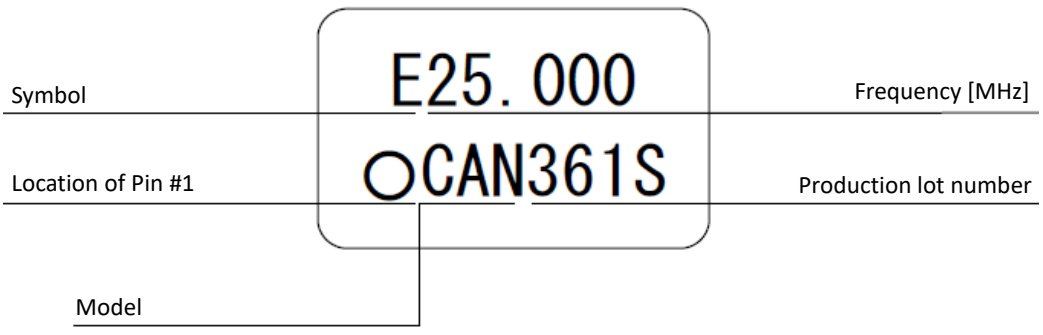
For stable operation, it is recommended that 0.01 µF to 0.1 µF bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 147 mg

Terminal Assignment

Pin #	Connection	Function		
#1	$\overline{ST}$	$\overline{ST}$ terminal		
		$\overline{ST}$ function	Osc. Circuit	Output
		"H" or OPEN	Oscillation	Specified frequency: Enable
		"L"	Oscillation stop	High impedance: Disable
#2	GND	GND terminal		
#3	OUT	Output terminal		
#4	V_{CC}	V_{CC} terminal		

Marking



[10] Moisture Sensitivity Level and Electro-Static Discharge Ratings

(10-1) Moisture Sensitivity Level (MSL)

Parameter	Specification	Conditions
MSL	LEVEL 1	IPC/JEDEC J-STD-020D.1

(10-2) Electro-Static Discharge (ESD)

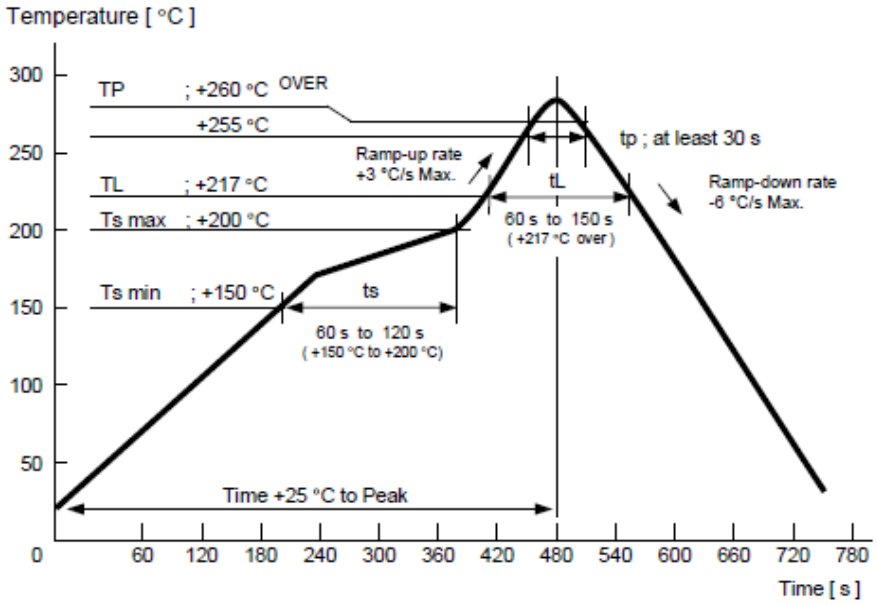
Parameter	Specification	Conditions
HBM	2 000 V Min.	EIAJ ED-4701-1 C111A, 100 pF, 1.5 kΩ, 3 times
MM	200 V Min.	EIAJ ED-4701-1 C111, 200 pF, 0 Ω, 1 time
CDM	750 V Min	AEC-Q100-011 (DCDM) * only for SG2016CAN

(10-3) Latch-Up

Parameter	Specification	Conditions
Latch-up	100 mA Min.	EIAJ ED-4701-1 C113

[11] Reflow Profiles

IPC/JEDEC J-STD-020D.1



[12] Packing Information

(12-1) SG2016CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004801xxxx**xx**) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

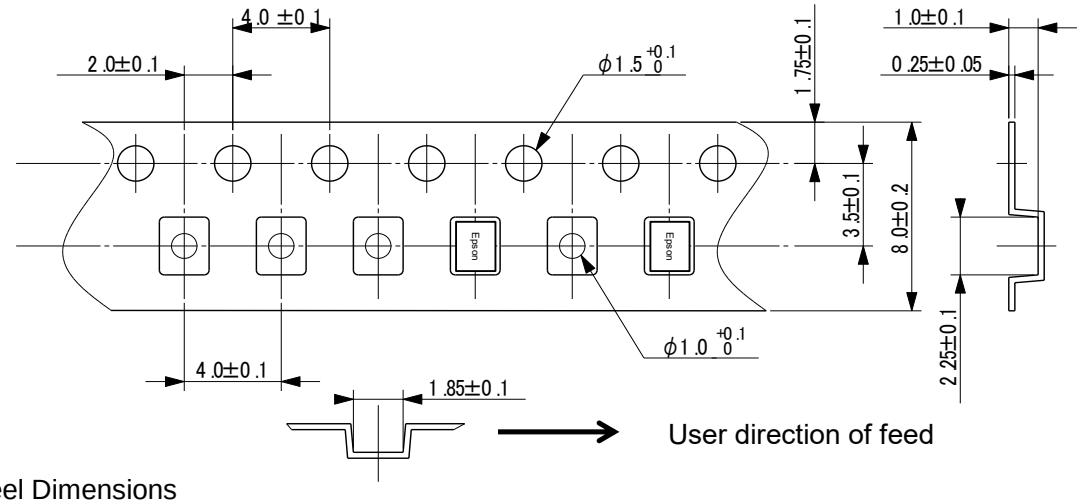
(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

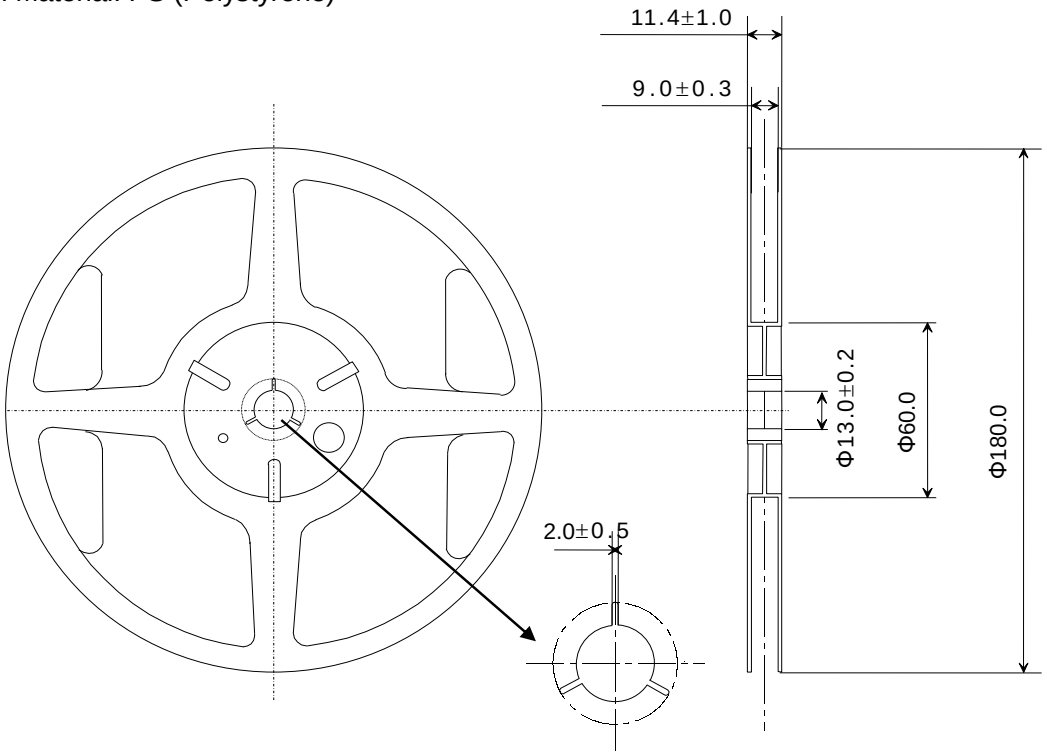
Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene) Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene)

Reel Material: PS (Polystyrene) Units: mm



3) Storage Environment

We recommend to keep less than +30 ºC and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

(12-2) SG-210STF

(1) Packing Quantity

The last two digits of the Product Number (X1G004171xxxx**xx**) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

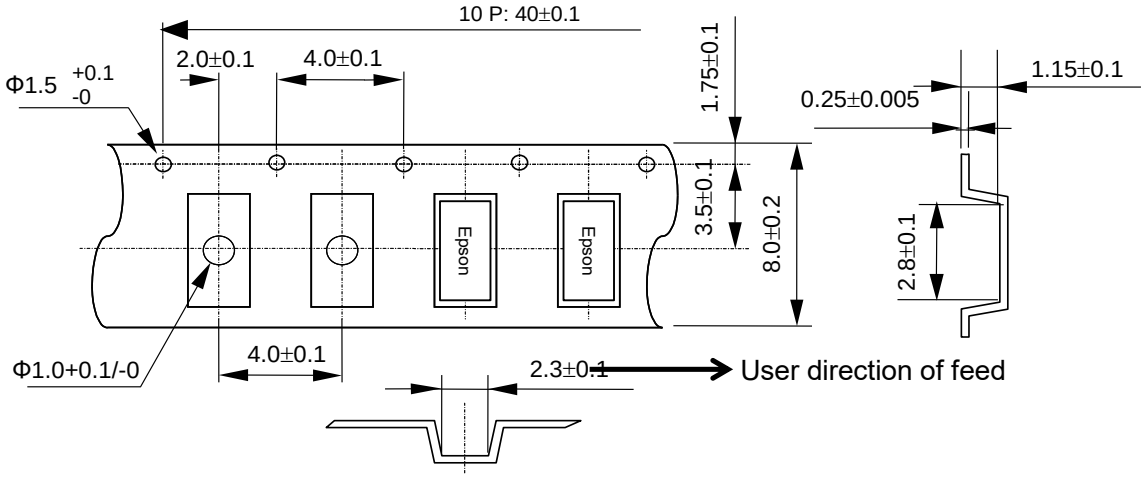
(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

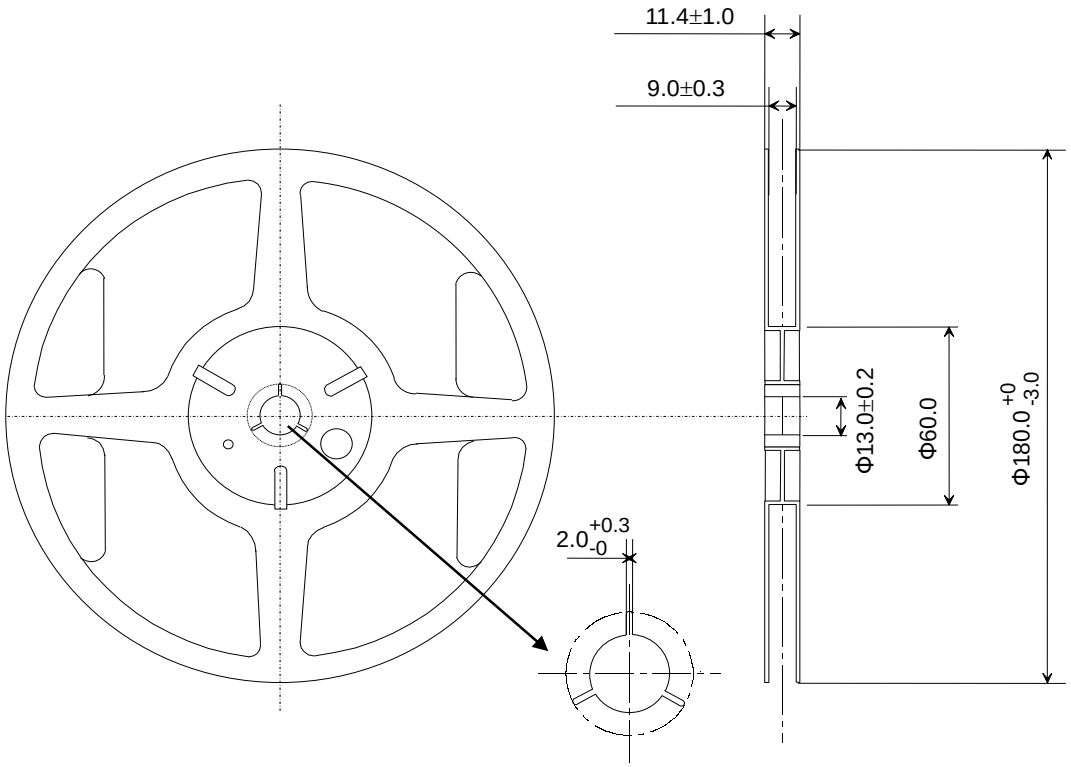
Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene) Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene)

Reel Material: PS (Polystyrene) Units: mm



3) Storage Environment

We recommend to keep less than +30 ºC and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

(12-3) SG3225CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G005961xxxx**xx**) are a code that defines the packing quantity. The standard is "15" for a 2 000 pcs/Reel.

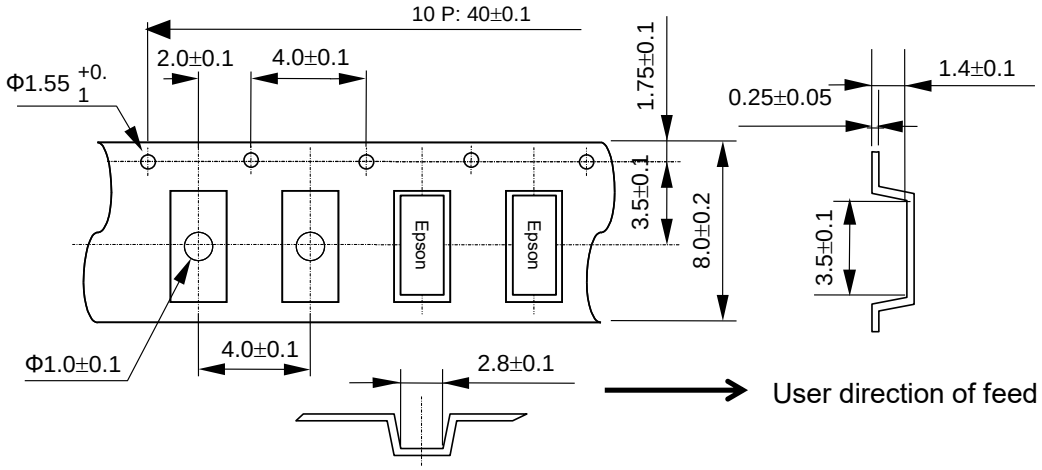
(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

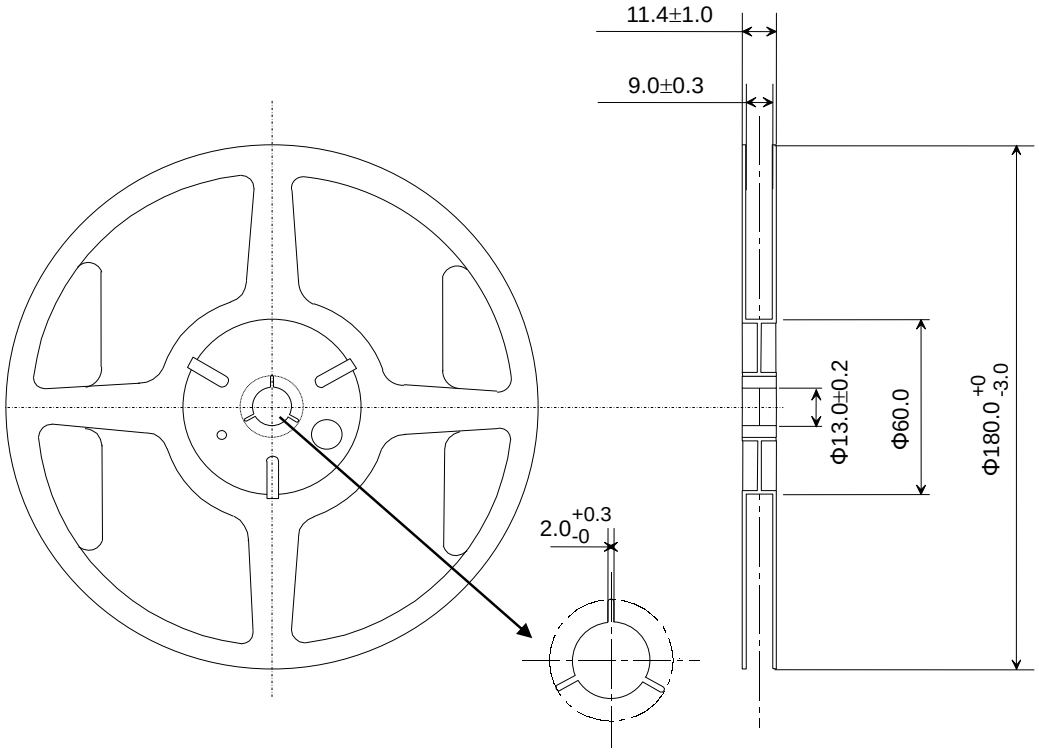
Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene) Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene)

Reel Material: PS (Polystyrene) Units: mm



3) Storage Environment

We recommend to keep less than +30 ºC and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

(12-4) SG5032CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004451xxxx**xx**) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

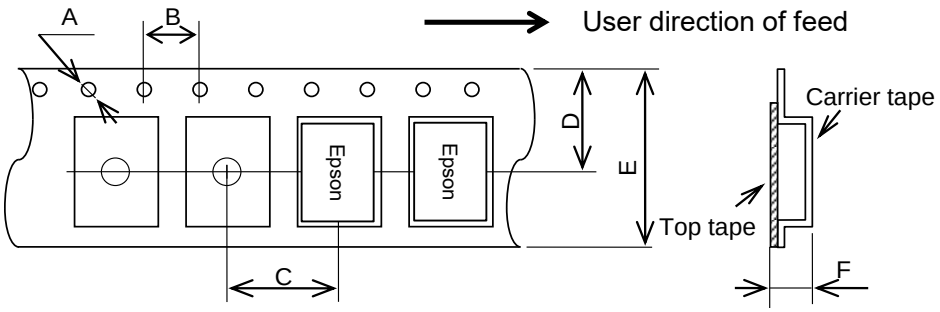
(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene) Units: mm

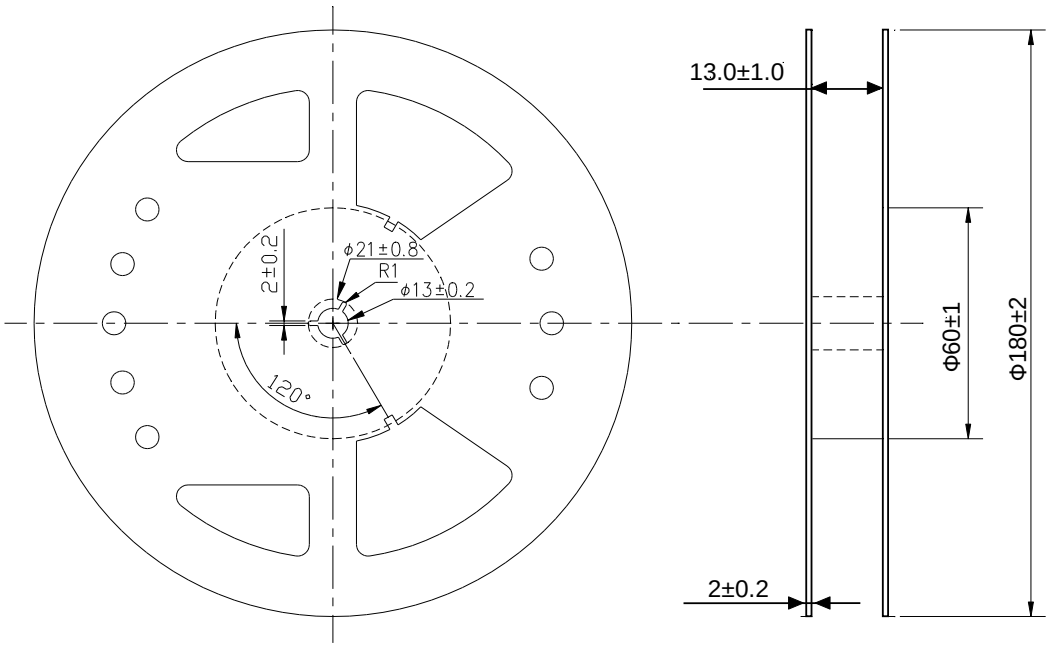


Symbol	A	B	C	D	E	F
Value	φ1.5 +0.1/-0	4.0±0.1	8.0±0.1	7.25±0.2	12.0±0.2	1.40±0.1

2) Reel Dimensions

Center Material: PS (Polystyrene)

Reel Material: PS (Polystyrene) Units: mm



3) Storage Environment

We recommend to keep less than +30 ºC and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

(12-5) SG7050CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004481xxxx**xx**) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

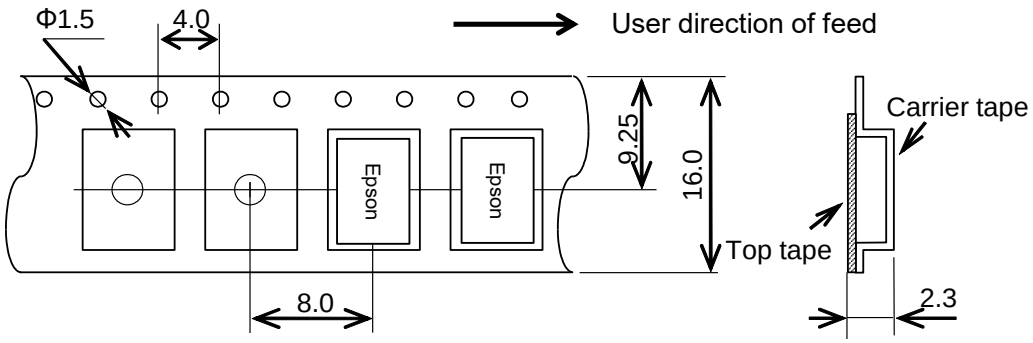
(2) Taping Specification

Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

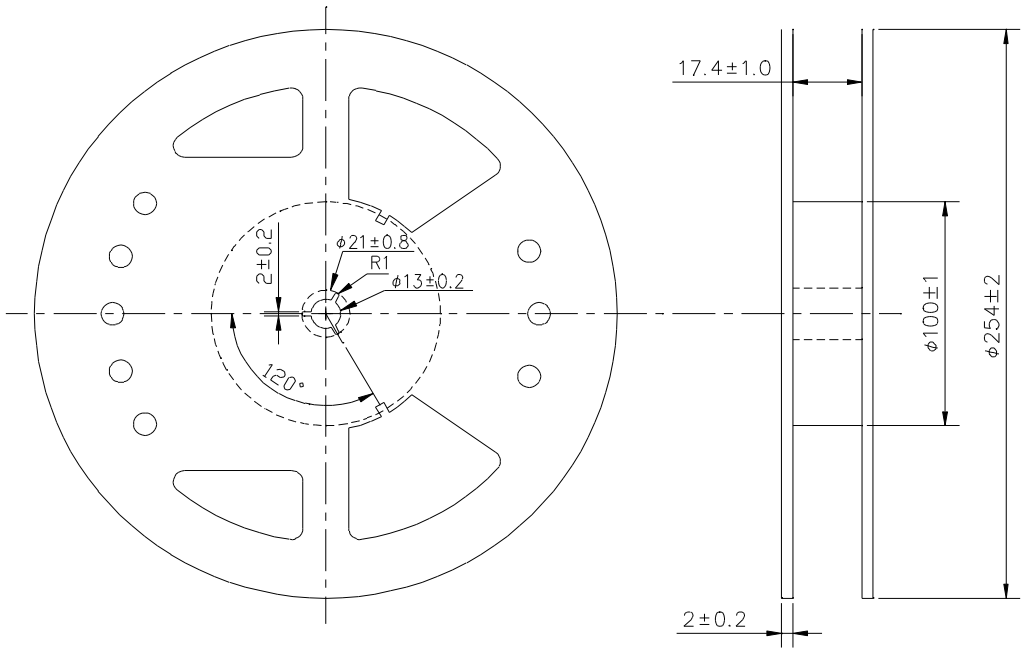
Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene) Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene)

Reel Material: PS (Polystyrene) Units: mm



3) Storage Environment

We recommend to keep less than +30 ºC and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

[13] Handling Precautions

Prior to using this product, please carefully read the section entitled “Precautions” on our Web site (https://www5.epsondevice.com/en/information/#precaution) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment.
Before using the product under any conditions other than those specified therein, please consult with us to verify and confirm that the performan
affected by use under such conditions.
In addition to the foregoing precautions, in order to avoid the deteriorating performance of the product, we strongly recommend that you DO NOT use the product under ANY of the following conditions:

(1) Mounting the product on a board using water-soluble solder flux and using the product without removing the residue of the flux completely from the board. The residue of such flux that is soluble in water or water-soluble cleaning agent, especially the residues which contains active halogens, will negatively affect the performance and reliability of the product.
(2) Using the product in any manner that will result in any shock or impact to the product.
(3) Using the product in places where the product is exposed to water, chemicals, organic solvent, sunlight, dust, corrosive gasses, or other materials.
(4) Using the product in places where the product is exposed to static electricity or electromagnetic waves.
(5) Applying ultrasonic cleaning without advance verification and confirmation that the product will not be affected by such a cleaning process, because it may damage the crystal,
(6) Using the product under any other conditions that may negatively affect the performance and/or reliability of the product.
(7) Power supply with ripple may cause of incorrect operation or degradation of phase noise characteristics, so please evaluate before use.
(8) Supply voltage should be increased monotonically.
In addition, please do not power on at midpoint potential since that may cause malfunction or not output.
(9) Frequency aging is from environmental tests results to the expectation of the amount of the frequency variation. This doesn't guarantee the product-life cycle.

Should any customer use the product in any manner contrary to the precautions and/or advice herein, such use shall be done at the customer’s own risk.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

■ Explanation of marks used in this datasheet

Pb Free	**●Pb free.**
RoHS Compliant	**●Complies with EU RoHS directive.** *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive (Contains Pb in sealing glass, high melting temperature type solder or other)

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